

# ENW89811x4CF

Bluetooth QD ID: Published after Qualification

## PAN1321-SPP

Infineon's

BlueMoonUniversal Platform

## Wireless Modules

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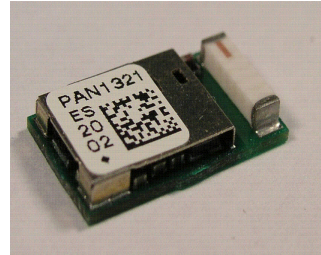
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## 1 General Device Overview

### 1.1 Features

#### General

- Complete Bluetooth 1.2, 2.0 and 2.0 + EDR solution
- Integrated stack with RFCOMM and SPP device profile
- Ultra low power design in 0.13  $\mu\text{m}$  CMOS
- Temperature range from  $-40^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$  (Optional  $+85^{\circ}\text{C}$ )
- Integrates ARM7TDMI, RAM and patchable ROM
- On-module voltage regulators. External supply 2.9-4.1 V
- On-module EEPROM with configurable data
- Reference clock included
- Low power clock from internal oscillator or external low power clock (e.g. 32.768 kHz)
- Dynamic low power mode switching with request signal for clock and power supply



#### Embedded application

- Embedded application loaded from external EEPROM running on top of the integrated stack
- Easy development of customer specific embedded applications
- Standard application SW offered, for example SPP with AT commands over UART.

#### Interfaces

- 3.25 MBaud UART
- General purpose I/Os with interrupt and wake-up capabilities
- JTAG for boundary scan and debug

#### RF

- Transmit power programmable from  $-45$  dBm to  $4.5$  dBm
- Transmit power typ.  $2.5$  dBm (default settings)
- Receiver sensitivity typ.  $-86$  dBm at 2Mbit/s (DQPSK)
- Integrated antenna switch, balun and antenna filter
- Integrated LNA with excellent blocking and intermodulation performance
- No external components, integrated antenna
- Digital demodulation for optimum sensitivity and co-/adjacent channel performance

#### Bluetooth

- Scatternet with one slave role while still being visible
- Power control and RSSI
- Sniff mode
- Adaptive Frequency Hopping
- Quality of Service
- Bluetooth security features: Authentication, Pairing and Encryption
- Bluetooth test mode and Infineon's active Bluetooth tester mode and RF test modes

### 1.2 Ordering Information

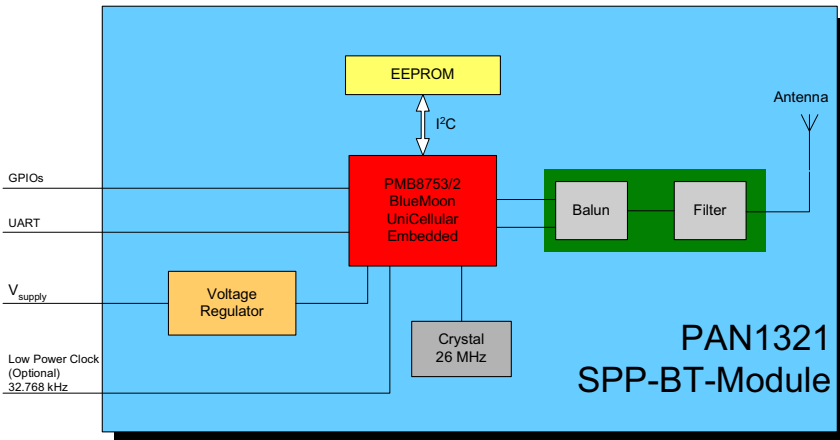
**Table 1-1 Ordering part number table**

| Ordering part number       | Description  | MOQ <sup>1)</sup> |
|----------------------------|--|-------------------|
| ENW8Z811J4CF <sup>2)</sup> | Engineering Sample<br>PAN1321 with SPP and max. +70°C (Consumer Range)   | 1                 |
| ENW8Z811K4CF <sup>2)</sup> | Engineering Sample<br>PAN1321 with SPP and max. +85°C (Industrial Range) | 1                 |

<sup>1)</sup> Abbreviation for Minimum Order Quantity (MOQ)

<sup>2)</sup> As long as the module has engineering status, the sign ES are available on the label. The “Z” in the ordering part number indicates the engineering sample status. After mass production the “Z” will be changed to the “9” and the ES sign on the label will be deleted.

### 1.3 Block Diagram



**Figure 1-1 Simplified block diagram of PAN1321.**

1.4 Pin Configuration LGA

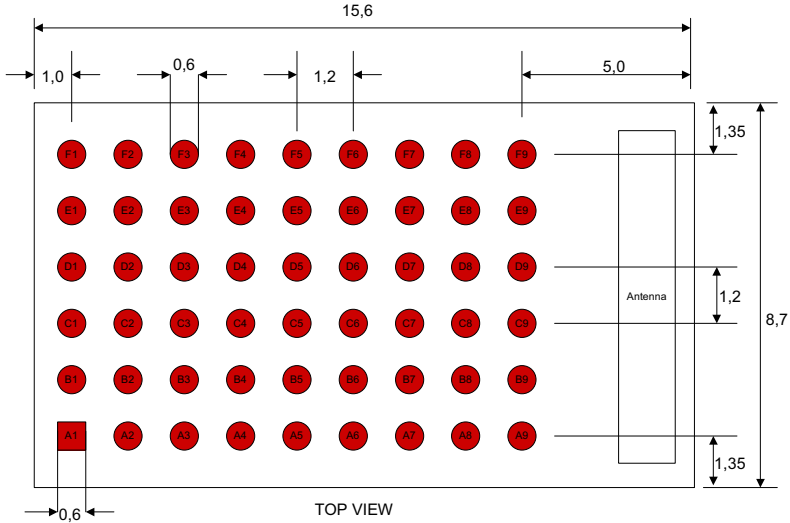


Figure 1-2 Pin Configuration for PAN1321 in Top View (footprint)

1.5 Pin Description

The non-shaded cells indicate pins that will be fixed for the product lifetime. Shaded cells indicate that the pin might be removed/changed in future variants. All pins not listed below shall be not connected.

Table 1-2 Pin description table

| Pin No. | Symbol            | Pin Type | Supply voltage | During Reset | Function                         |
|---------|-------------------|----------|----------------|--------------|----------------------------------|
| A2      | P1.6/<br>GATE_OUT | DIO-UD   | Internal1      | Z            | Port 1.6 or<br>Logic gate output |
| A3      | RESET#            | AI       | Internal1      | Input        | Hardware Reset                   |

## General Device Overview

| Pin No. | Symbol                    | Pin Type | Supply voltage | During Reset     | Function   |
|---------|---------------------------|----------|----------------|------------------|--|
| A8      | P1.5/<br>CLK32            | DIO-UD   | Internal1      | Input            | Port 1.5 or<br>LPM clock input (e.g. 32.768kHz)          |
| B1      | P1.7                      | DIO-UD   | Internal1      | PD/ Input        | Port 1.7   |
| B2      | P1.8                      | DIO-UD   | Internal1      | PD               | Port 1.8   |
| B3      | P1.0/<br>TMS              | DIO-UD   | Internal2      | PU <sup>1)</sup> | Port 1.0 or<br>JTAG interface                            |
| B4      | P1.4/<br>RTCK             | DIO-UD   | Internal2      | Z                | Port 1.4 or<br>JTAG interface                            |
| B5      | ONOFF                     | DI       |                | -                | Turns off module completely                              |
| B9      | P0.15/<br>SLEEPX/<br>TST3 | DIO-UD   | VDDUART        | PD               | Port 0.15 or<br>CLKIN & VDDSUP request or<br>Test output |
| C2      | P0.9                      | DIO-UD   | Internal2      | Z                | Port 0.9   |
| C3      | JTAG#                     | DI       | Internal2      | PU               | Mode selection Port 1:<br>0: JTAG<br>1: Port             |
| C4      | TRST#                     | DI       | Internal2      | PD               | JTAG interface   |
| D1      | P0.10/<br>TST1            | DIO-UD   | Internal2      | Z                | Port 0.10 or<br>Test output                              |
| D2      | P0.8/<br>TST0             | DIO-UD   | Internal2      | PD               | Port 0.8 or<br>Test output                               |
| D3      | P1.1/<br>TCK              | DIO-UD   | Internal2      | PU <sup>1)</sup> | Port 1.1 or<br>JTAG interface                            |
| D4      | P0.3                      | DIO-UD   | VDD1           | Conf.<br>PD def. | Port 0.3   |
| D5      | P0.2                      | DIO-UD   | VDD1           | Z                | Port 0.2   |
| E1      | P0.12/<br>SDA0            | DIO-U    | Internal2      | PU               | Port 0.12 or<br>I2C data signal                          |
| E2      | P0.13/<br>SCL0            | DIO-U    | Internal2      | PU               | Port 0.13 or<br>I2C clock signal                         |
| E3      | P1.3/<br>TDO              | DIO-UD   | Internal2      | Z                | Port 1.3 or<br>JTAG interface                            |
| E4      | P0.0                      | DIO-UD   | VDD1           | PD               | Port 0.0   |
| E5      | P0.1                      | DIO-UD   | VDD1           | PD               | Port 0.1   |
| E6      | P0.5/<br>UARTRXD          | DIO-UD   | VDDUART        | Z                | Port 0.5 or<br>UART receive data                         |
| F2      | P1.2/<br>TDI              | DIO-UD   | Internal2      | PU <sup>1)</sup> | Port 1.2 or<br>JTAG interface                            |
| F3      | P0.11/<br>TST2            | DIO-UD   | Internal2      | Z                | Port 0.11 or<br>Test output                              |
| F4      | P0.14                     | DIO      | VDDUART        | Z                | Port 0.14  |

## General Device Overview

| Pin No.  | Symbol           | Pin Type | Supply voltage | During Reset | Function                             |
|--|------------------|----------|----------------|--------------|--------------------------------------|
| F5   | P0.7/<br>UARTCTS | DIO-UD   | VDDUART        | Z            | Port 0.7 or<br>UART CTS flow control |
| F7   | P0.4/<br>UARTTXD | DIO-UD   | VDDUART        | PU           | Port 0.4 or<br>UART transmit data    |
| F8   | P0.6/<br>UARTRTS | DIO-UD   | VDDUART        | PU           | Port 0.6 or<br>UART RTS flow control |
| A4, A5, A6                                       | VSUPPLY          | SI       |                | -            | Power supply                         |
| C1   | VREG             | SO       |                | -            | Regulated Power supply               |
| F6   | VDDUART          | SI       |                | -            | UART interface Power supply          |
| C5   | VDD1             | SI       |                | -            | Supply voltage interface pads        |
| A1, A7, A9, C8,<br>C9, D7, D8, E8,<br>E9, F1, F9 | VSS              |          |                | -            | Ground                               |

<sup>1)</sup> Fixed pull-up/pull-down if JTAG interface is selected, not affected by any chip reset. If JTAG interface is not selected the port is tristate.

Descriptions of acronyms used in the pin list:

| Acronym | Description   |
|---------|---|
| I       | Input   |
| O       | Output  |
| DI      | Digital input   |
| DIO-UD  | Digital input/output with support for open drain, pull-up and pull-down |
| DIO-U   | Digital input/output with support for open drain and pull-up            |
| Z       | Tristate  |
| PU      | Pull-up   |
| PD      | Pull-down   |
| A       | Analog (e.g. AI means analog input)                                     |
| S       | Supply (e.g. SO means supply output)                                    |

## 1.6 FW version

PAN1321 is available in different versions. Please check corresponding release documents for latest information.

1.7 System Integration

PAN1321 is a complete Bluetooth subsystem optimized for data transfer applications. It has all required interfaces and is designed to have a low bill of material (BOM) and small PCB area. The device includes Bluetooth protocol stack, HID and RFCOMM profiles in ROM. Additional profiles and application software can be downloaded to the system. **Figure 1-3** shows a typical SPP application.

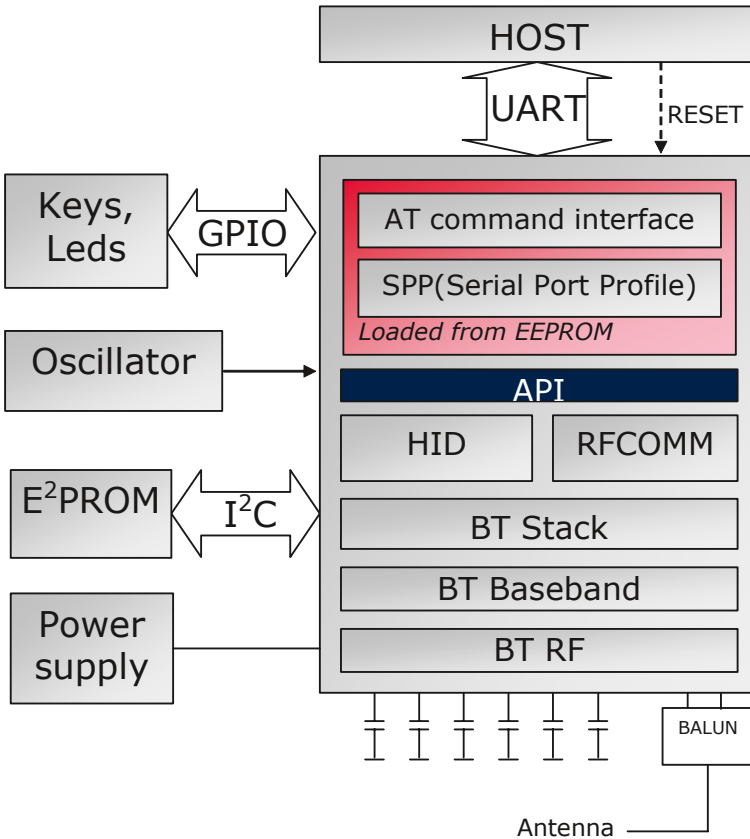


Figure 1-3 Example SPP application with PAN1321

### General Device Overview

Different interface options are available depending on the used profile and application. In all applications, the I2C interface is used for connection to the integrated EEPROM in PAN1321.

The EEPROM contain application software, additional profiles if needed and configuration data including the Bluetooth address.

Depending on application, the UART can be used for sending commands to PAN1321 and for transferring data to remote device. The 4-wire UART has an own power supply to ensure compatibility with the I/O voltages used by the system host.

Low power mode control of PAN1321 is implemented using signalling over the UART interface. Wake-up functionality of GPIOs can also be used to control low power modes. The host can reset PAN1321 via the RESET# signal, this methods will force PAN1321 to enter its lowest power mode. When using the ONOFF pin, the module will be turn off completely.

GPIOs are available in several voltage domains, programmable to be inputs or outputs and to have pull-up, pull-down or tri-state status.

PAN1321 supports clocking both from a crystal and from an existing reference clock. The low power clock (32 kHz) is generated internally, but an external 32 kHz clock can also be applied.

One single power supply is used to supply PAN1321. Integrated regulators supply all required voltages in the device.

The SLEEPX signal indicates when CLKIN and VSUPPLY are needed by PAN1321. This can be used to switch off the external oscillator and regulators when they are not needed.

## 2 Basic Operating Information

### 2.1 Power Supply

PAN1321 is supplied from a single supply voltage VSUPPLY (Pin A4, A5 and A6). This supply voltage must always be present. The Bluemoon UniCellular chip is supplied from an internally generated 2.5 V supply voltage. This voltage can be accessed from the VREG (Pin C1). This voltage may not be used for supplying other components in the host system but can be used for referencing the host interfaces.

The PCM interface and the UART interface are supplied with dedicated, independent, reference levels via the VDD1 (Pin C5) and VDDUART (Pin F6) pins. All other digital I/O pins are supplied internally by either 2.5 V (Internal2) or 1.5 V (Internal1). [Section 1.5](#) provides a mapping between pins and supply voltages.

The I/O power domains (VDD1 and VDDUART) are completely separated from the other power domains and can stay present also in low power modes.

### 2.2 Clocking

BlueMoon UniCellular has one clock input CLK32 that is optional. If used this 32.768 kHz clock must always be present to assist BlueMoon UniCellular to keep the time in low power modes.

The low power clock can be generated internally by the crystal oscillator and/or the low power oscillator or provided externally

### 2.3 Reset

There are different ways to reset PAN1321 with slightly different behavior. [Table 2-1](#) shows what happens to BD\_DATA and patches for different types of reset.

**Table 2-1 Different types of reset**

|   | BD_DATA   | Patches  |
|---|---|----------|
| Power-on reset                              | Set to default values   | Disabled |
| External reset (RESET#)                     | Set to default values if <i>Save_RAM_BD_Data</i> = 0.<br>Kept if <i>Save_RAM_BD_Data</i> = 1. | Disabled |
| HCI Reset issued by embedded application    | Kept  | Kept     |
| Leaving manufacturer mode with Reset = 0x01 | Kept  | Disabled |
| Leaving manufacturer mode with Reset = 0x02 | Kept  | Enabled  |

## 2.4 Low Power Modes

To minimize current consumption, BlueMoon UniCellular automatically switches between different low power modes. The major modes are described below.

### 2.4.1 Clock Disabling Mode

As soon as a part of BlueMoon UniCellular is inactive, the clocks to that part are disabled. This can be done very quickly and is done without host intervention.

### 2.4.2 Low Power Mode

In Low Power Mode (LPM) most parts of BlueMoon UniCellular are powered down. The reference clock is still running. Entering and leaving LPM cannot be done as quickly as disabling/enabling clocks since internal state must be saved and restored, but the power consumption is lower in LPM. The minimum time of inactivity that is required to enter LPM is configured with the BD\_DATA parameter *LPM\_Threshold*.

In addition to this dynamic control, low power modes must be globally enabled. This is done by the embedded application or with an AT command in the SPP application case. The value *Default\_LPM\_Mode* in BD\_DATA parameter *LPM\_Conf* controls if low power modes are enabled or disabled after reset. The value *AutoDisable\_LPM* in the same parameter controls if low power modes should be disabled after host initiated wakeup.

### 2.4.3 Ultra Low Power Mode

Ultra Low Power Mode (ULPM) is similar to LPM with the addition that the reference clock may be switched off. If VDDPM is externally supplied, the main supply voltage VDDSUP may also be switched off. Bluetooth state is updated using the low power clock. Leaving ULPM takes longer time than leaving LPM because the reference clock must be started. The minimum time of inactivity that is required to enter ULPM is configured with the BD\_DATA parameter *ULPM\_Threshold*. The accuracy of the low power clock is specified with the parameter *LPM\_Drift*.

The signal SLEEPX is used to indicate when BlueMoon UniCellular enters ULPM. **Figure 2-1** shows an example with the default polarity of SLEEPX. When SLEEPX goes low the system is allowed to switch off VDDSUP and CLKIN. When BlueMoon UniCellular wants to leave ULPM it sets SLEEPX high again to request VDDSUP and CLKIN. The internal low power state machine waits for a time *Osc\_Settle* for the power supply and clock to stabilize before starting the rest of the system. The parameter *Osc\_Settle* is configurable in BD\_DATA.

ULPM is controlled and enabled in the same way as LPM.

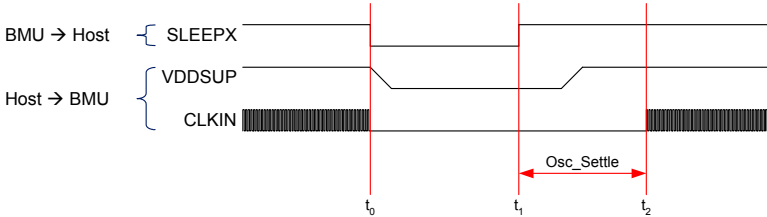


Figure 2-1 SLEEPX indicating Ultra Low Power Mode

### 2.4.4 Complete Power Down

If Bluetooth functionality is not needed at all, VDDSUP and VDDPM should be grounded to minimize power consumption. In this state there is no activity in BlueMoon UniCellular and the Bluetooth state (native clock, etc.) is not updated.

### 2.5 SLEEPX Configurations

The SLEEPX signal can be configured in different ways to fit the host system's clock and power supply requests. The behavior after firmware startup can be configured with HCI+ commands and BD\_DATA parameters. The polarity of SLEEPX can be selected with a bit in the BD\_DATA parameter *BB\_Conf*. Some typical system configurations are shown below.

#### Separate Power Supply and Clock Request Signals

The simplest case is when BlueMoon UniCellular and the rest of the system has separate signals to request power and clocks. This is shown in [Figure 2-2](#).

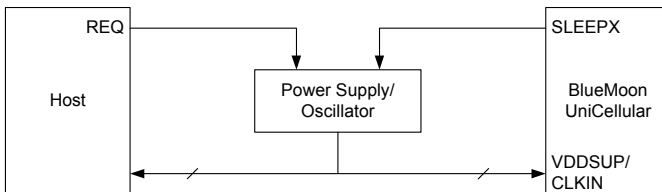
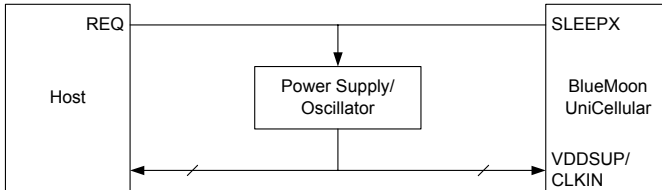


Figure 2-2 Separate Power Supply and Clock Request Signals

## Basic Operating Information

### Shared Power Supply and Clock Request Signals

If the SLEEPX signal and the host's request signal are configured to pull in one direction and drive in the other, it is possible to wire the signals together. This is shown in [Figure 2-3](#).



**Figure 2-3 Shared Power Supply and Clock Request Signals**

### 3 Interfaces

#### 3.1 UART Interface

The UART interface is the main communication interface between the host and PAN1321 in applications where serial port communication is included. One example is the SPP application, where communication is made with AT commands over the UART. In the case of a customer specific embedded application, the UART can be controlled by the application through an API described [Ref \[1\]](#).

The interface consists of four UART signals as shown in [Figure 3-1](#). Depending on the application, some or all of the signals are needed.

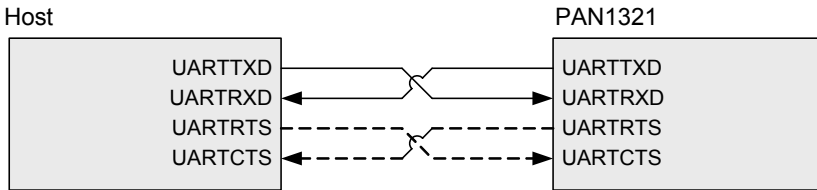


Figure 3-1 UART Interface

##### 3.1.1 UART

The on-chip UART (Universal Asynchronous Receiver and Transmitter) is compatible with standard UARTs. Hardware support for SLIP<sup>1)</sup> framing and 16-bit CRC calculation is available for embedded applications. A separate supply voltage, VDDUART, makes it easy to connect the UART interface to any system.

###### 3.1.1.1 Baud Rates

The UART baud rate can be configured by the application through the API described in [Ref \[1\]](#).

The supported baud rates are listed in [Table 3-1](#) together with the small deviation error that results from the internal clock generation. The default baud rate is 115200 Baud.

<sup>1)</sup> See <http://www.ietf.org/rfc/rfc1055.txt> for information about SLIP.

**Table 3-1 UART Baud Rates**

| Wanted Baud Rate | Real Baud Rate | Deviation Error (%) |
|------------------|----------------|---------------------|
| 9600             | 9615           | 0.16                |
| 19200            | 19230          | 0.16                |
| 38400            | 38461          | 0.16                |
| 57600            | 57522          | -0.14               |
| 115200           | 115044         | -0.14               |
| 230400           | 230088         | -0.14               |
| 460800           | 464285         | 0.76                |
| 921600           | 928571         | 0.76                |
| 1843200          | 1857142        | 0.76                |
| 3250000          | 3250000        | 0                   |

### 3.1.1.2 Detailed UART Behavior

After reset the UART interface is configured with one start bit, eight data bits, no parity bit and one stop bit. The least significant bit is transmitted first.

The polarity of the UART signals can be changed by the application software through the API described in [Ref \[1\]](#). The default (non-inverted) behavior is shown in [Table 3-2](#)

**Table 3-2 Default (non-inverted) behavior of UART signals**

| Signal            | Level | Meaning                          |
|-------------------|-------|----------------------------------|
| UARTTXD / UARTRXD | 0     | Start bit, '0' bit in character. |
|                   | 1     | Idle level, stop bit             |
| UARTRTS / UARTCTS | 0     | Flow on                          |
|                   | 1     | Flow stopped                     |

To prevent the system from floating signal lines while PAN1321 is in low power mode, the application software can activate internal pull-up or pull-down resistors through the API described in [Ref \[1\]](#).

### UARTCTS Response Time

[Figure 3-2](#) shows the UARTCTS response time. Assuming non-inverted UART signals, the data flow stops within the “flow off response time” after UARTCTS has been set to high. If UARTCTS goes high during the transmission of a byte (phase 1 in the figure) this

byte will be completely transmitted. While UARTCTS is high, no data will be transmitted (phase 2). When UARTCTS goes low again, data transmission will continue (phase 3). The maximum flow off response time is 10 UART bits (including start and stop bits). As an example, if the UART baud rate is 115200 Baud, the maximum flow off response time is  $10 \times 1/115200 \text{ s} = 87 \mu\text{s}$ .

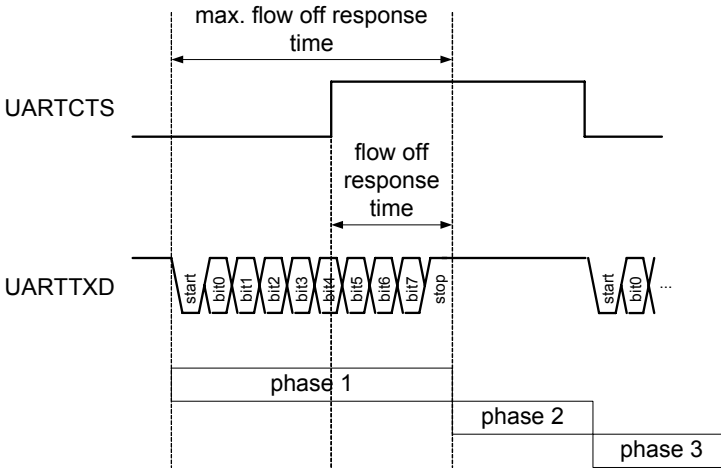


Figure 3-2 UARTCTS response time

### 3.1.2 Low Power Mode Protocol

In PAN1321 the general Low Power Mode settings are governed by the BD\_DATA .

The real-time handling of Low Power Modes are handled by the application software through the API described in [Ref \[1\]](#).

For standard applications using the UART, like the SPP application, the behaviour is described in the corresponding Software Description Document.

## 3.2 GPIO Interface

### 3.2.1 General Purpose I/Os

Most digital pins on PAN1321 can be used as general purpose I/Os (GPIOs). The GPIO pins are grouped into two ports: P0 and P1. P0 has 16 pins (P0.0 - P0.15) and P1 has nine pins (P1.0 - P1.8). Information about each pin's placement and capabilities can be found in the pin description in [Section 1.5](#).

The GPIOs are completely controlled by the application software through the API (described in [Ref \[1\]](#)). For standard applications the control of GPIOs is described in the corresponding Software Description documents.

### 3.3 Internal EEPROM / I2C Interface

PAN1321 supports storage of non-volatile information in the internal EEPROM connected to the I2C interface.

The EEPROM contains the following partitions:

- The Bluetooth Device Data (BD\_DATA) Storage
- The Application and patches to the firmware
- Application data (any application specific data)
- Production default values

The partition table and each partition are protected by checksums.

The partition table and the partitions in EEPROM are described in detail in [Ref \[1\]](#).

The application software can read and write to the EEPROM through the API described in [Ref \[1\]](#), through standard HCI commands (e.g. HCI\_Change local name) or through Infineon specific HCI+ commands (e.g. Infineon\_write\_BD\_Data).

#### 3.3.1 I2C Hardware

The I2C hardware is compatible with standard I2C interfaces. It supports data rates of up to 400 kbit/s. Currently only 7-bit addressing and master mode is supported.

The application software can access the I2C Hardware through the API described in [Ref \[1\]](#).

## 4 General Device Capabilities

This chapter describes features available in the PAN1321 core.

Actual feature set and how to access the features can be found in [Ref \[1\]](#) in case of access from an embedded customer application or in the corresponding Software Description Documents for standard applications.

### 4.1 Embedded Application

At startup or reset, PAN1321 loads the embedded application from external EEPROM into internal RAM and starts the application. If no valid application is found in the EEPROM, PAN1321 starts a default ROM application. This application will restart the chip to retry loading the application.

Thus, to work correctly, PAN1321 requires an external EEPROM that has been programmed with an external programming tool.

In the case of a Standard Application from Infineon, e.g. the SPP application, Infineon supplies a complete EEPROM image.

In the case of a customer specific application, the user can write the application in C or assembly language and produce the EEPROM image through a tool-chain consisting of Infineon supplied tools and commercially available SW development tools.

During development of a customer specific embedded application, it is also possible to load the application directly into the internal RAM with a JTAG debugger.

How to produce a customer specific EEPROM image and how to load and debug an embedded application is described in detail in [Ref \[1\]](#).

### 4.2 HCI+ and Bluetooth Device Data (BD\_DATA)

In addition to the standard Bluetooth HCI commands and events, PAN1321 supports a set of Infineon specific commands and events called HCI+. All Infineon specific features are accessed using the HCI+ commands described in [Ref \[1\]](#).

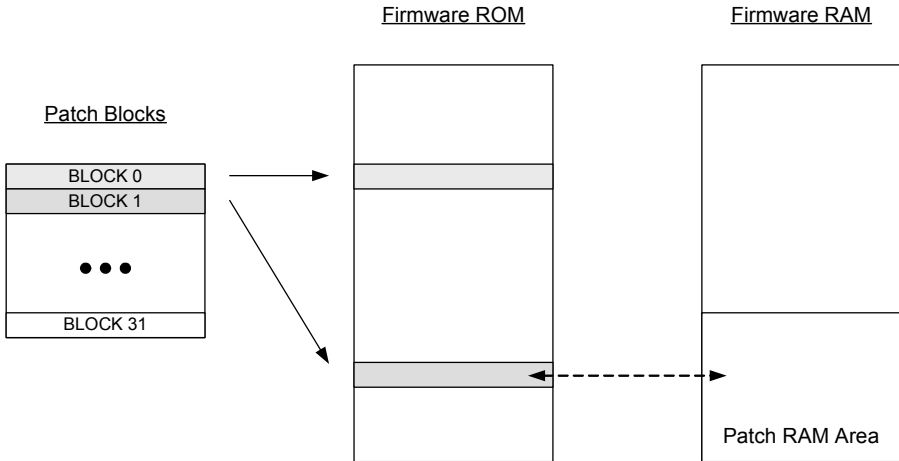
All configuration information that is critical for correct operation of PAN1321 is called Bluetooth Device Data (BD\_DATA). This data is stored in PAN1321's internal RAM for fast access and in non-volatile memory (external EEPROM).

### 4.3 Firmware ROM Patching

#### 4.3.1 Patch Support

PAN1321 contains dedicated hardware that makes it possible to apply patches to any code and data in the firmware ROM. The hardware is capable of replacing up to 32 blocks of 16 bytes each with new content.

**Figure 4-1** shows an example where two blocks in firmware ROM have been replaced. The dashed arrow shows that the second block makes use of code and/or data in the RAM area.



**Figure 4-1 Patch Hardware**

### 4.3.2 Handling Patches

In PAN1321 the patches are stored in a partition of the external EEPROM. At start up, the firmware copies the patch data to internal RAM and sets up the hardware to enable the patches.

If patches are needed in the Standard Application case, they are included in the EEPROM image containing all other EEPROM partitions (Standard Application, BD Data, etc.) and shall be programmed into the EEPROM using external tooling. This EEPROM image is supplied by Infineon.

For a customer specific application, the EEPROM image including any necessary patches is produced with tooling described in [Ref \[1\]](#).

## 4.4 Hardware and Software Version Information

The application can get detailed information about the hardware and software versions of PAN1321 using HCI+ commands described in [Ref \[1\]](#).

## 4.5 Advanced Error Reporting

PAN1321 has the capability to detect and report various error conditions to the application. The following types of errors can be distinguished:

**Fatal Exception:** A fatal error has been detected and PAN1321 cannot continue normal operation. The device performs a reset and reports the error with an Infineon Fatal Exception event.

**Debug Exception:** An error has been detected but PAN1321 can continue normal operation. The exception is reported with an Infineon Debug Exception event.

**Hardware Error:** Hardware error conditions are reported with the Hardware Error event that is defined in the Bluetooth specification.

**Watchdog Reset:** A watchdog timer guarantees that PAN1321 is restarted if the firmware stops working for some reason. The condition is reported with a Hardware Error event.

The reporting is done through HCI+ events to the application. The events and how to clear the exceptions are described in [Ref \[1\]](#).

## 5 Bluetooth Capabilities

### 5.1 Supported Features

PAN1321 supports all mandatory and optional features in the Bluetooth 2.0 + EDR specification, except for the features listed in [Chapter 5.2](#).

Including:

- Enhanced Data Rate up to 3 Mbit/s
- Adaptive Frequency Hopping (AFH)
- All ACL packet types
- All LMP features
- Authentication, Pairing and Encryption
- Quality of Service
- Sniff
- Role Switch
- RSSI and Power Control
- Power class 2 and 3
- Scatternet with one slave role while still being visible
- Standard Bluetooth test mode, Active Tester Mode and RF Test Modes

### 5.2 Not Supported features

- Synchronous links
- Hold mode
- Park state
- Broadcast
- CQDDR
- HCI remote loopback

### 5.3 PAN1321 Specifics and Extensions

This chapter describes features available in the PAN1321 core.

Actual feature set and how to access the features can be found in:

- [Ref \[1\]](#) in case of access from an embedded application
- the corresponding Software description Document in case of a standard application

#### 5.3.1 Configurable LMP Features

PAN1321 supports all feature bits that are defined in the Bluetooth 2.0 + EDR specification. The host can disable unwanted LMP features with the `BD_DATA` parameter `LMP_Features`. The following rules apply:

- A feature is fully supported if the corresponding feature bit is set.

## Bluetooth Capabilities

- If a feature bit is not set, the link manager behaves as if the feature was not supported. If the feature is requested by the local host or the remote link manager the request will be denied.
- Depending on the feature bits, PAN1321 behaves as a Bluetooth 1.1, 1.2 or 2.0+EDR device. If at least one of the feature bits corresponding to Bluetooth 1.2 (e.g. AFH) is set, PAN1321 behaves as a Bluetooth 1.2 device. If at least one of the feature bits corresponding to Bluetooth 2.0+EDR (e.g. 3-slot EDR packets) is set, PAN1321 behaves as a Bluetooth 2.0+EDR device.

Some of the feature bits do not follow the general rules:

- **Flow Control Lag:** The flow control lag is a characteristic of the firmware and cannot be configured. The *Flow Control Lag* bits should be set to zero.
- **Enhanced Inquiry Scan:** Enhanced Inquiry Scan is always used whether or not the feature bit is set.

A list of all features can be found in section 3.3 in the Bluetooth 2.0 + EDR specification.

### 5.3.2 Local Device

#### 5.3.2.1 HCI Command Flow Control

PAN1321 is able to buffer two HCI command packets and starts performing the commands in the order in which they are received. Execution of a command can be started before the previous command has been completed. Commands that involve the page procedure (i.e. `HCI_Create_Connection` and `HCI_Remote_Name_Request`) cannot be performed at the same time since two page procedures cannot be performed simultaneously; the second command will be delayed until the first has completed.

#### 5.3.2.2 HCI Buffers

PAN1321 supports the following number of HCI buffers and buffer sizes (as returned by the `HCI_Read_Buffer_Size` command):

**Table 5-1**

| Type | Number of Buffers | Size of each Buffer |
|------|-------------------|---------------------|
| ACL  | 11                | 339                 |

#### 5.3.2.3 Event Filtering

Up to 15 event filters are supported with the HCI command `Set_Event_Filter`.

**5.3.2.4 Local Name**

PAN1321 can store a local name with a length of 100 bytes (excluding the 0x00 termination character). The local name can be stored in RAM or in non-volatile memory (external EEPROM). The place of storage is configured with the *Local\_Name* field in the *BD\_DATA* parameter *BB\_Conf*.

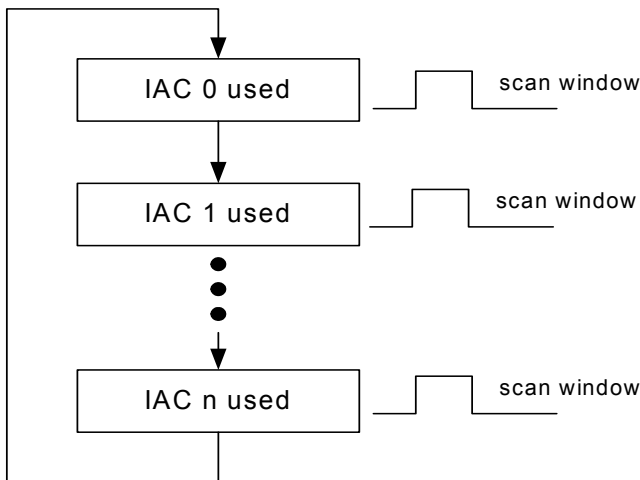
**5.3.3 Discovery and Connection Establishment**

**5.3.3.1 Multiple Inquiry Access Codes**

PAN1321 can scan for up to five inquiry access codes (IACs) during inquiry scan. The number can be read with *HCI\_Read\_Number\_Of\_Supported\_IAC*. The IACs can be read and written with *HCI\_Read\_Current\_IAC\_LAP* and *HCI\_Write\_Current\_IAC\_LAP*.

The IACs will be used cyclically in consecutive scan windows. The number of IACs has no influence on the scan window and scan interval settings. Consequently, the overall scan time for each IAC is proportionally reduced. If interlaced scan is enabled, the same IAC is used for both interlaced scan windows. The IACs provided by the host may be identical to allow prioritization of one IAC over the others.

Figure 5-1 shows the use of multiple IACs.



**Figure 5-1 Use of Multiple IACs**

### 5.3.3.2 Page and Page Scan

PAN1321 supports the mandatory paging scheme, paging modes P0, P1 and P2 and scan repetition modes R0, R1 and R2. The default page scan repetition mode is R1.

### 5.3.4 During Connection

#### 5.3.4.1 Scatternet and Piconet Capabilities

PAN1321 supports point-to-point and scatternet scenarios:

- Up to 2 links
- Maximum 1 simultaneous slave role
- Always capable of responding to inquiry and remote name request
- Always capable of Inquiry

#### 5.3.4.2 Role Switch

Only one role switch can be performed at a time. If a role switch request is pending, other role switch requests on the same or other links are rejected. If a role switch fails, PAN1321 will automatically try again a maximum of three times. Encryption (if present) is stopped in the old piconet before a role switch is performed and re-enabled when the role switch has succeeded or failed. If the physical link is in Sniff a role switch will not be performed.

#### 5.3.4.3 Dynamic Polling Strategy

In addition to the regular polling scheme, PAN1321 dynamically assigns unused slots to links where data is exchanged. This adapts very well to bursty traffic and improves throughput and latency on the links.

#### 5.3.4.4 Adaptive Frequency Hopping (AFH)

PAN1321 supports adaptive frequency hopping according to the Bluetooth 2.0 + EDR specification. AFH switch and channel classification are supported both as master and slave. Channel classification from the host is also supported.

A number of HCI+ commands and events are available to provide information about AFH operation. The commands `Infineon_Enable_AFH_Info_Sending` and `Infineon_Disable_AFH_Info_Sending` turn on and off the Infineon AFH Info events that provide detailed information about channel classification, channel maps, interferers, etc.

If enabled by the `Infineon_Enable_Infineon_Events` command, the Infineon AFH Extraordinary RSSI event informs the host whenever extraordinary RSSI measurements in unused slots have been started. This is done when the number of known good channels has decreased below a critical limit and periodically after a defined time.

The `Infineon_Set_AFH_Measurement_Period` command can be used to configure the duration of the AFH measurement period.

### 5.3.4.5 Quality of Service (QoS)

PAN1321 supports quality of service according to the Bluetooth 2.0 + EDR specification. It is recommended to use the `HCI_Flow_Specification` command to set the QoS parameters for both outgoing and incoming traffic. The old `HCI_QoS_Setup` command can be used to set the QoS parameters for outgoing traffic.

The outgoing QoS parameters `Access_Latency/Latency` and `Token_Rate` are used to set the poll interval. The incoming QoS parameter `Access_Latency` is used to define the maximum reassembly time. (To optimize throughput, PAN1321 tries to fill internal buffers before sending received data to the host. If a buffer has not been filled "maximum reassembly time" after a packet has been received, the buffer will be sent to the host anyway.) The default maximum reassembly time is the same as the default poll interval (40 slots).

If both QoS and EDR are enabled in PAN1321 and supported by the remote device, PAN1321 automatically tries to switch to EDR if the QoS bandwidth requirements are too high to be supported by basic rate. For power saving reasons, the QoS algorithm makes use of EDR packets whenever the RF quality is high enough.

In order to make the QoS algorithm work efficiently the host should always allow all packet types. It may disallow the use of 5-slot packets or restrict the packet types to 1-slot packets completely but should not use other combinations.

## 5.3.5 Security

### 5.3.5.1 Authentication

Authentication can be performed at connection creation or during connection.

The repeated attempts algorithm described in section 5.1 in the Bluetooth 2.0 + EDR specification is implemented with the following parameters:

The first waiting interval is 5 seconds. After each subsequent authentication failure the waiting interval is doubled. Every 30 seconds the waiting interval falls back one step. The maximum waiting interval is 40 seconds.

### 5.3.5.2 Link Key Management

Up to five link keys can be stored with `HCI_Write_Stored_Link_Key`. The link keys are stored in RAM or non-volatile memory if available.

### 5.3.5.3 Encryption

Encryption can be enabled at connection creation or during connection if an authentication has been performed. Both point-to-point and broadcast encryption are supported.

When PAN1321 is connected to several other devices as master and broadcast encryption is requested, a common encryption key length will be chosen to maximize the number of devices that can be included in the broadcast encryption group. Devices that cannot accept the settings will be disconnected.

The minimum and maximum encryption key sizes accepted by PAN1321 can be set and read with the HCI+ commands `Infineon_Set_Encryption_Key_Size` and `Infineon_Read_Encryption_Key_Size`.

### 5.3.5.4 Pairing

The HCI+ command `Infineon_Write_Pairing_Mode` can be used to set PAN1321 in pairable or non-pairable mode.

## 5.3.6 RSSI and Output Power Control

### 5.3.6.1 Received Signal Strength Indication (RSSI)

PAN1321 supports received signal strength measurements and uses LMP signaling to keep the output power of a remote device within the golden receive power range. The range is set with the `BD_DATA` parameters *RSSI\_Min* and *RSSI\_Max*.

### 5.3.6.2 Output Power Control

PAN1321 supports power control according to the Bluetooth 2.0 + EDR specification.

- The output power can be controlled in 3 or 4 steps (configurable). PAN1321 can work as a class 2 or 3 device depending on the settings.
- Fine tuning can be used on the power steps.

The following `BD_DATA` parameters are used for configuration:

*RF\_Psel\_D*, *RF\_Psel\_Conf*, *RF\_Conf*, *TX\_Power\_Ref#*.

### 5.3.6.3 Ultra Low Transmit Power

For high security devices the output power can be reduced to a value that reduces the communication range to a few inches. This mode is enabled with the HCI+ command `Infineon_TX_Power_Config`.

### 5.3.7 Test Modes

PAN1321 supports the standard Bluetooth test mode (DUT) and two Infineon specific test modes, Active Tester Mode and RF Test Modes.

#### 5.3.7.1 Active Tester Mode

PAN1321 can act as a Bluetooth RF tester running the Bluetooth test mode. All defined test mode scenarios can be configured and initiated with the HCI+ command `Infineon_Active_Tester`. Detailed information about the active tester mode is available in the HCI+ specification in [Ref \[1\]](#).

#### 5.3.7.2 RF Test Modes

RF transmitter and receiver measurements can be done in the following test modes:

- TX burst mode
- RX burst mode
- RX burst mode with data transparently sent to host
- RX bit & packet error rate measurement mode

The modes are configured with the HCI+ command `Infineon_Test_Mode`. Detailed information about the modes is available in the HCI+ specification in [Ref \[1\]](#).

#### 5.3.7.3 EDR Packet Test Command

The HCI+ command `Infineon_Test_EDR_Packets` can be used to force PAN1321 to use enhanced data rate or basic rate. This will be done without LMP negotiation and should only be used for testing.

### 5.3.8 Debugging

#### 5.3.8.1 LMP Tracing and Sending

An LMP trace mode makes it possible to trace the LMP traffic between PAN1321 and other devices without an external protocol analyzer. The LMP PDUs that are sent and received are sent to the host with the Infineon LMP PDU Trace event. The trace events are activated with the `Infineon_Activate_Deactivate_Traces` command.

It is also possible to send an LMP PDU to another device. This is done with the HCI+ command `Infineon_Send_LMP`.

### 5.3.8.2 Error Events

The following Infineon specific error events exist:

**Table 5-2 Error Event Table**

| Event                           | Description   |
|---------------------------------|---|
| Infineon Invalid ACL_BC_PB Flag | Indicates that PAN1321 has received an HCI packet with invalid BC or PB flag from the host.         |
| Infineon Invalid ACL_CNC_Handle | Indicates that PAN1321 has received an ACL HCI packet with invalid connection handle from the host. |

### 5.3.8.3 Information Events

With the HCI+ command Infineon\_Enable\_Infineon\_Events it is possible to enable and disable the following information events:

**Table 5-3 Information Event Table**

| Event                            | Description   |
|----------------------------------|---|
| Infineon PTT Switch Notification | Indicates that the packet type table (PTT) has been switched.                                   |
| Infineon Scan Status             | Indicates that the link manager has temporarily changed the scan settings provided by the host. |
| Infineon Debug Exception         | Indicates an internal problem in PAN1321.   |

## 6 AT-Specification

### 6.1 Introduction

This chapter describes the AT commands applicable to Panasonic's PAN1321 Bluetooth solution for embedded applications. The product utilizes a raw AT set of commands and events over UART command set for Bluetooth communications and control on an embedded device.

Please refer to [Ref \[3\]](#) for actual status of the SPP software.

### 6.2 Serial Port Profile

Host communication sent over UART is always called command except while in stream mode, see below. All communication received by host application over UART is called response except while in stream mode.

#### 6.2.1 Operation Modes

The specification defines two operation modes of the PAN1321-SPP. For Bluetooth SPP there are furthermore two different roles specified; A-device (paging device) setting up the over the air connection and B-device which is connectable and accepts the connection (page scanning device).

##### 6.2.1.1 Command mode

In this mode the SPP application running on the PAN1321 will execute the AT commands sent from the Host over the UART using the H4 UART protocol as specified within the Bluetooth SIG [\[Ref \[2\]\]](#). In this mode, the Host application can send data to the PAN1321, which are transmitted to the other device which has a Bluetooth connection on SPP level with the PAN1321. This mode is normally used when transmitting bursty and packetized data. Setting up/accepting Bluetooth SPP connections and/or searching for other Bluetooth devices are also other operations done in this mode.

##### 6.2.1.2 Stream mode

In this mode, the Host application will send un-packetized data to the PAN1321, and is transmitted over the air to the other device. This mode is normally used when transmitting small size of data in a random way and for serial cable replacement applications.

### 6.2.2 Pin Assignments

**Table 6-1**

| Pin Name | Module Pin Number | IC Pin Number    | Direction | Description |
|----------|-------------------|------------------|-----------|-------------|
| UART_RXD | E6                | P0.5 (Reserved)  | I         | UART        |
| UART_TXD | F7                | P0.4 (Reserved)  | O         | UART        |
| UART_RTS | F8                | P0.6 (Reserved)  | O         | UART        |
| UART_CTS | F5                | P0.7 (Reserved)  | I         | UART        |
| SDA      | E1                | P0.12 (Reserved) | I         | I2C         |
| SCL      | E2                | P0.13 (Reserved) | I         | I2C         |
| GPIO 0   | E4                | P0.0             | I/O       | LPM         |
| GPIO 8   | F4                | P0.14            | I/O       | LPM         |
| GPIO 1   | E5                | P0.1             | I/O       | APPL GPIO   |
| GPIO 2   | D5                | P0.2             | I/O       | APPL GPIO   |
| GPIO 3   | D4                | P0.3             | I/O       | APPL GPIO   |
| GPIO 4   | D2                | P0.8             | I/O       | APPL GPIO   |
| GPIO 5   | C2                | P0.9             | I/O       | APPL GPIO   |
| GPIO 6   | D1                | P0.10            | I/O       | APPL GPIO   |
| GPIO 7   | F3                | P0.11            | I/O       | APPL GPIO   |
| GPIO 9   | B9                | P0.15            | I/O       | APPL GPIO   |

### 6.3 AT SPP command and response

AT commands can only be sent while in command mode with the exception of stream connection cancel (^^^) which can be sent in stream mode. The expected response after sending an AT command is the "OK" response, see specification below. The host shall wait for a command to be terminated before sending a new one. A command is considered as terminated when "OK" and all subsequent related responses have been received.

There are also responses, which are not initiated by a sent command. They are in that case initiated by the remote Bluetooth device.

#### 6.3.1 AT command and response format and syntax

All data exchanged between the host and eBMU is in ASCII format.

## AT-Specification

Parameters for commands and responses are given in decimal (DEC) base in ASCII format unless hexadecimal (HEX) base is specified.

MSB is always sent first. eBMU does not distinguish between upper and lower cases.

Example for values with decimal base in ASCII format:

The number 255 in decimal corresponds to the following three characters '2', '5', '5'. E.g. AT+JSDA=010,1234567890 (the number 10 is given by three ASCII characters '0', '1', '0').

Example for values with hexadecimal base in ASCII format:

The number 255 in decimal base corresponds to the number FF in hexadecimal base, thereby the number in ASCII format for hexadecimal base is represented by the following two characters 'F', 'F'.

E.g. +RSNFCNF=3E80,2 ; The four ASCII characters '3', 'E', '8', '0' represent the number 3E80 in hexadecimal base which corresponds to 16000 in decimal base.

### 6.3.1.1 AT-commands

All AT-commands follow the format below:

AT+<command>=<parameter 1 (if required)>,<parameter 2 (if required)>,<parameter 3 (if required)> ,<...><carriage return><line feed>

E.g.: AT+JCCR=0010c64d67dc,01 (to connect to BD\_ADDR "0010c64d67dc", service channel 1)

### 6.3.1.2 AT-responses

All AT-responses follow the format below with the exception of <OK> and <ERROR=>;  
+<response>=<parameter 1 (if required)>,<parameter 2 (if required)>,<parameter 3 (if required)>,<...><carriage return><line feed>

E.g.: +RDAI =0010c64d67dc,DATA ( "DATA" received from 0010c64d67dc )

**6.3.1.3 AT response parameter list for <status>, <state> and <ERROR>**

- Values for <status> general for all commands

**Table 6-2 Command execution status value table**

| <b>Values for &lt;status&gt; general for all commands</b> | <b>Status Value</b> |
|---|---------------------|
| BT_OK   | 0                   |
| BT_CONGESTED  | 1                   |
| BT_CALL_ERROR   | 2                   |
| BT_CONTROL_CMD_COMPLETE                                   | 3                   |
| BT_CONTROL_CMD_PENDING                                    | 4                   |
| BT_FAILED   | 5                   |
| BT_BAD_CONFIG   | 6                   |
| For future use  | 7-15                |

- General error messages.

**Table 6-3 General Error Message Table**

| <b>Error Message</b>                          | <b>Error Code</b> |
|---|-------------------|
| SPP Error                                     | 0                 |
| Syntax Error                                  | -1                |
| Command not allowed at present general status | -2                |

### 6.3.2 AT command list table

**Table 6-4**

| AT Command                | Usage  | Resulting response(s) from PAN1321 | DevA / Dev B |
|---------------------------|--|------------------------------------|--------------|
| AT+JAAC=<br><auto_accept> | <p><b>Auto Accept Connection requests</b><br/>           Forces PAN1321 to accept connection requests.</p> <p><u>auto_accept parameter (1 octet):</u><br/>           0 - Host will be notified on incoming connection indication (+RCOI) - (no auto accept).<br/>           Default value<br/>           1 - PAN1321 will automatically auto accept incoming connection request - (host will be notified but connection is accepted automatically)</p> | OK                                 | Dev B        |
| AT+JACR= <accept>         | <p><b>Accept Connection Request</b><br/>           Shall be used as answer to a connect indication (+RCOI).</p> <p><u>accept parameter (1 octet):</u><br/>           0 - Not accepted<br/>           1 - Accepted</p>  | OK                                 | Dev B        |

**Table 6-4**

| AT Command                       | Usage  | Resulting response(s) from PAN1321  | DevA / Dev B   |
|----------------------------------|--|---|----------------|
| AT+JEDT                          | <p><b>Enable Device under Test</b><br/>           This SPP-AT command enables the device under test. After this command has been sent it is possible for a remote tester to connect, this AT command corresponds to the three different HCI commands listed below:</p> <ol style="list-style-type: none"> <li>1. Set Event Filter - allow all connections.</li> <li>2. Write Scan Enable - page and Inquiry.</li> <li>3. Enable device under test.</li> </ol> <p>Note: JEDT command can only be issued with security mode 1 and after production mode is enabled (JPRO=1).</p> | OK  | Dev A<br>Dev B |
| AT+JCAC=<br><trim_value>,<GPIO > | <p><b>Crystal Auto Calibrate</b></p> <p><u>trim_value parameter (4 octets / HEX base):</u><br/>           The trim value is used to adjust the frequency on the GPIO chosen by the GPIO parameter. <u>GPIO parameter (4 octets / HEX base):</u><br/>           Two GPIOs can be used as output for the 32768 Hz clock P01 and P08 (0002 and 0100).</p> <p>Note: JCAC command can only be issued after production mode is enabled (JPRO=1).</p>   | <p>+RCACCNF=<br/>           &lt;osc_trim&gt;<br/>           osc_trim parameter(4 octets / HEX base)</p> <p>Use AT+JCBD to store the osc_trim value to EEPROM.</p> | Dev A<br>Dev B |

**Table 6-4**

| AT Command        | Usage   | Resulting response(s) from PAN1321 | DevA / Dev B   |
|-------------------|---|------------------------------------|----------------|
| AT+JCBD=<bd_data> | <p><b>Change BD_Data</b><br/> <u>bd_data parameter (116 octets / HEX base)</u>; (reference values)<br/>           msg.bdAddr (12 octets)= see note1<br/>           msg.channelWordOffset (4 octets)=0000;<br/>           msg.clkConf (2 octets)= 8A;<br/>           msg.eepromSize (2 octets)=80;<br/>           msg.inputFreq (8 octets)=018CBA80;<br/>           msg.lmpFeatures (16 octets)=000019987E0602BF;<br/>           msg.lpmConf (2 octets)=40;<br/>           msg.lpmDrift (2 octets)=FA;<br/>           msg.lpmThreshold (2 octets)=12;<br/>           msg.ulpmThreshold (2 octets)=18;<br/>           msg.pmuConfig (4 octets)=0080;<br/>           msg.rfPselID (8 octets)=06050403;<br/>           msg.rfPselConf (2 octets)=44;<br/>           msg.rssiMin (2 octets)=0C;<br/>           msg.rssiMax (2 octets)=10;<br/>           msg.ddcTlConf (2 octets)=02;<br/>           msg.uartBaudrate (2 octets)=04;<br/>           msg.uartInvert (2 octets)=00;<br/>           msg.uartPulls (2 octets)=01;<br/>           msg.oscSettle (2 octets)=08;<br/>           msg.bbConf (2 octets)=04;<br/>           msg.rfConf (2 octets)=04;<br/>           msg.txPowerRef0 (2 octets)=F2;<br/>           msg.txPowerRef1 (2 octets)=F8;<br/>           msg.txPowerRef2 (2 octets)=FE;<br/>           msg.txPowerRef3 (2 octets)=04;<br/>           msg.oscTrim (4 octets)=see note 2;<br/>           msg.threeWireArqTimeout (2 octets)=06;<br/>           msg.LMP_Version (2 octets)=00;<br/>           msg.Reserved (16 octets)=0000000000000000;</p> <p>Note 1: This value shall be configured with the desired Bluetooth device Address (e.g. FFAA010203BB).</p> <p>Note 2: This value shall be configured with the value found during crystal calibration (see command AT+JCAC).</p> <p>Note 3: JCBD command can only be issued after production mode is enabled (JPRO=1). Changes in BD Data take place after production mode command is disabled (JPRO=0) followed by a SW reset (AT+JRES).</p> | OK                                 | Dev A<br>Dev B |

**Table 6-4**

| AT Command                          | Usage  | Resulting response(s) from PAN1321  | DevA / Dev B |
|-------------------------------------|--|---|--------------|
| AT+JCCR=<bd_addr>,<service channel> | <p><b>Create Connection Request</b><br/>           Instructs PAN1321 to connect to a remote Bluetooth device (prospective slave).</p> <p><u>bd_addr parameter (12 octets / HEX base):</u><br/>           The Bluetooth address of the remote device</p> <p><u>service_channel parameter (2 octets / DEC base):</u><br/>           0-30<br/>           Which service channel to connect to can be received from a Service Discovery (AT+JSDS)</p> | <p>OK<br/>           (Followed by):<br/>           +RCCRCNF=&lt;MTU_size&gt;,&lt;status&gt;<br/>           MTU_size parameter (3 octets / DEC base)<br/>           status parameter (1 octet)</p> <p>If maximum number of allowed connections already exists:<br/>           ERR=0.</p>   | Dev A        |
| AT+JDDS=<limit_inquiry_result>      | <p><b>Device Discovery Start</b><br/>           Causes PAN1321 to start a Device Discovery (Inquiry and Remote Name Request) of the Bluetooth neighborhood.</p> <p><u>limit_inquiry_result parameter (1 octet):</u><br/>           0- The maximum number of responses that can be obtained is 8.<br/>           1- The number of responses will be 8 devices.</p>  | <p>OK<br/>           (Then, if responses are returned):<br/>           +RDDSRES=&lt;bd_addr&gt;<br/>           &lt;remote_name&gt;,&lt;COD&gt;<br/>           (For each response)</p> <p>bd_addr parameter (12 octets / HEX base).<br/>           remote_name parameter (variable length):<br/>           Name of the remote device.<br/>           Page Timeout is received as a name if the remote name is not found during device discovery<br/>           COD parameter (6 octets / HEX base).<br/>           Class of device</p> <p>(Completed by):<br/>           +RDDSRES=&lt;status&gt;<br/>           status parameter (1 octet)</p> | Dev A        |

**Table 6-4**

| AT Command                               | Usage   | Resulting response(s) from PAN1321  | DevA / Dev B   |
|--|---|---|--|
| <p>AT+JDIS=<br/>&lt;discoverable&gt;</p> | <p><b>DIScoverable</b><br/>Forces PAN1321 into Page Scan / Inquiry Scan states indefinitely (note: this makes the device discoverable).</p> <p><u>discoverable parameter (1 octet):</u><br/>0-No scans enabled.<br/>1-Inquiry Scan enabled.<br/>2-Page Scan enabled.<br/>3-Inquiry &amp; Page Scan enabled.</p> <p>Note: Default value after a HW reset is no scans enabled</p>                               | <p>OK</p>   | <p>Dev B</p> <p>Dev A can be discoverable but not accept incoming connections.</p> |
| <p>AT+JDOI</p>                           | <p><b>Download Application Image via UART</b><br/>After "OK" response a binary file with the EEPROM image should be sent.</p> <p>File open and send in binary format after "OK" is received.</p> <p>Note: JDOI command can only be issued after production mode is enabled (JPRO=1). Changes in the EEPROM image are effective after production mode command is disabled (JPRO=0) followed by a HW reset.</p> | <p>OK after command is sent.</p> <p>+RDOICNF after .eep file has been written.</p> <p>Note: PAN1321 calculates the size of the image that is being downloaded from the file header. The response +RDOICNF is generated when the calculated size is reached.</p> | <p>Dev A<br/>Dev B</p>   |

**Table 6-4**

| AT Command                   | Usage  | Resulting response(s) from PAN1321  | DevA / Dev B                      |
|------------------------------|--|---|-----------------------------------|
| AT+JGPA=<read>,<set>,<clear> | <p><b>GPIO action</b><br/>           All parameters of this command are bit fields of 16 bits corresponding to GPIOs P0.15 to P0.0.<br/>           E.g. if pin P0.0 is the desired bit; the bit field value is 0001 and if the desired bit is P0.12 the bit field value is 0800.</p> <p><u>read parameter (4 octets / Hex base):</u><br/>           Values for each bit:<br/>           0- No Action<br/>           1- Read</p> <p><u>set parameter (4 octets / HEX base):</u><br/>           Values for each bit:<br/>           0-No Action<br/>           1-Set</p> <p><u>clear parameter (4 octets / HEX base):</u><br/>           Values for each bit:<br/>           0-No Action<br/>           1- Clear</p> | <p>+GPOACNF=&lt;value&gt;</p> <p>value parameter (4 octets / HEX base):<br/>           This value is the state of the GPIO PINs specified in read parameter.<br/>           Values for each bit:<br/>           0 - means low.<br/>           1 - means high.</p> | <p>Dev A<br/>           Dev B</p> |

**Table 6-4**

| AT Command   | Usage   | Resulting response(s) from PAN1321 | Dev A / Dev B  |
|--|---|------------------------------------|----------------|
| AT+JGPC=<br><direction>,<br><open_drain>,<br><pull_on/off>,<br><pull_up/down>,<br><tristate> | <p><b>GPIO Configuration</b></p> <p>All parameters of this command are bit fields of 16 bits corresponding to GPIOs P0.15 to P0.0 (See command AT+JGPA).</p> <p><u>direction parameter (4 octets / HEX base):</u><br/>           Values for each bit:<br/>           1 - IN<br/>           0 - OUT</p> <p><u>open_drain parameter (4 octets / HEX base):</u><br/>           Values for each bit:<br/>           1 - OPEN</p> <p><u>pull_on/off parameter (4 octets / HEX base):</u><br/>           Values for each bit:<br/>           1 - Pull ON<br/>           0 - Pull OFF</p> <p><u>pull_up/down parameter (4 octets / HEX base):</u><br/>           Value for each bit:<br/>           1 - Pull UP</p> <p><u>tristate parameter (4 octets / HEX base):</u><br/>           Value for each bit:<br/>           1 - Tristate</p> | OK                                 | Dev A<br>Dev B |
| AT+JSLN=<br><length_friendly_name>,<br><friendly_name>                                       | <p><b>Set Local device friendly Name</b></p> <p>Supports all ASCII characters.</p> <p><u>length_friendly_name parameter (2 octets / DEC base):</u><br/>           Length of friendly name, the maximum value for length is 18.</p> <p><u>friendly_name parameter (length=length_friendly_name):</u><br/>           No delimiter is required.</p>  | OK                                 | Dev A<br>Dev B |

**Table 6-4**

| AT Command                                   | Usage   | Resulting response(s) from PAN1321  | Dev A / Dev B  |
|--|---|---|----------------|
| AT+JPCR=<br><length_PIN_code>,<br><PIN_code> | <p><b>PIN Code Reply</b><br/>           Sent to PAN1321 in response to a PIN Code Request from a remote Bluetooth device (bd_addr).</p> <p><u>length_PIN_code parameter (2 octets / DEC base):</u><br/>           Values= 1-16<br/>           Length of PIN code</p> <p><u>PIN_code parameter (length=length_PIN_code):</u><br/>           The PIN Code to be sent to the remote Bluetooth device, e.g.<br/>           AT+JPCR=04,1234</p> <p>Note: the PIN code is an ACII string.</p> | OK<br>(Followed by):<br>+RPCRCNF=<status><br>status parameter (1 octet)   | Dev A<br>Dev B |
| AT+JPRO=<mode>                               | <p><b>PROduction mode</b><br/> <u>mode parameter (1 octet):</u><br/>           1= Production mode ON<br/>           0= Production mode OFF</p>  | OK  | Dev A<br>Dev B |
| AT+JRBD                                      | <p><b>Read Bluetooth device Data</b><br/>           Sent to PAN1321 to retrieve the Bluetooth Device Address and the Oscillator trimming value.</p>   | +RRBDRES=<bd_addr>,< oscTrim><br><br>bd_addr parameter (12 octets / HEX base):<br>BD Address of remote device<br><br>oscTrim parameter (4 octets / HEX base)<br>Oscillator trim value | Dev A<br>Dev B |
| AT+JRES                                      | <p><b>RESet</b><br/>           SW reset of the system.</p>  | ROK as applications is restarted.   | Dev A<br>Dev B |
| AT+JRRRI                                     | <p><b>Read Revision Information</b></p>   | +RRRICNF=<revision><br><br>revision parameter (2 octets / HEX base)   | Dev A<br>Dev B |

**Table 6-4**

| AT Command   | Usage   | Resulting response(s) from PAN1321 | DevA / Dev B   |
|--|---|------------------------------------|----------------|
| AT+JRLS=<uuid>,<br><length_service_name ><br><service_name>,<br><service channel >,<br><CoD> | <p><b>Register Local Service</b></p> <p><u>uuid parameter (4 octets / HEX base):</u><br/>           uuid for supported profile<br/>           e.g.1101 for Serial Port Profile</p> <p><u>length_service_name parameter (2 octets / DEC base):</u><br/>           Values=1-16<br/>           Length of service name</p> <p><u>service_name parameter (length=length_service_name):</u><br/>           Name for the service, no final delimiter is needed</p> <p><u>service channel parameter (2 octets / DEC base):</u><br/>           Values range: 0-30<br/>           Which service channel to connect to; can be received from a Service Discovery with AT+JSDS</p> <p><u>CoD parameter (6 octets / HEX base):</u><br/>           Class of device. The default CoD value is 000000</p> | OK                                 | Dev B          |
| AT+JRTRD=<bd_addr>   | <p><b>Remove Trusted Device</b> - deletes the trusted device information for a registered device (bd_addr).</p> <p><u>bd_addr parameter (12 octets / HEX base):</u><br/>           The Bluetooth address of the device that shall be removed from the list</p>  | OK                                 | Dev A<br>Dev B |
| AT+JSCR  | <p><b>Stream Connection Request</b><br/>           Connects the SPP and UART streams, transparent communication will be enabled if both sides execute this command.</p>   | OK                                 | Dev A<br>Dev B |

**Table 6-4**

| AT Command                | Usage  | Resulting response(s) from PAN1321   | DevA / Dev B   |
|---------------------------|--|--|----------------|
| AT+JSDA=<length>,<data>   | <p><b>Send Data Request</b></p> <p><u>length parameter (3 octets / DEC base):</u><br/>number of bytes to be sent</p> <p><u>data parameter (see note for size):</u><br/>data to be sent</p> <p>Note: Maximum number of bytes for each packet is reported at connection confirmation (MTU_Size) MTU size for PAN1321 is 256 bytes but this parameter is negotiated under connection.</p> | OK   | Dev A<br>Dev B |
| AT+JSDR                   | <p><b>SPP Disconnect Request</b></p> <p>Forces an SPP disconnection.</p>   | OK   | Dev A<br>Dev B |
| AT+JSDS=<bd_addr>,< uuid> | <p><b>Service Discovery Start</b></p> <p>Causes PAN1321 to start a service discovery of device with <u>bd_addr</u> and search for services defined by <u>uuid</u>.</p> <p><u>bd_addr parameter (12 octets / HEX base):</u><br/>BD Address of remote device</p> <p><u>uuid parameter ( 4 octets / HEX base):</u><br/>Service to search for e.g. 1101 for Serial Port Profile</p>        | <p>OK</p> <p>(Then, if services are returned):</p> <p>+RSDSRES=&lt;remote_service_name&gt;,&lt;remote_service_channel&gt;</p> <p>remote_service_name parameter (variable length):<br/>Name of the remote service.</p> <p>remote_service_channel parameter (2 octets / DEC base)</p> <p>(For each service)<br/>(Completed by):<br/>+RSDSCNF=&lt;status&gt;<br/>status parameter (1 octet)</p> | Dev A          |

**Table 6-4**

| AT Command   | Usage  | Resulting response(s) from PAN1321 | Dev A / Dev B          |
|--|--|------------------------------------|------------------------|
| <p>AT+JSEC=<br/>&lt;security_mode&gt;,<br/>&lt;Link_key_information&gt;,<br/>&lt;PIN_type&gt;,<br/>&lt;length_PIN_code&gt;,<br/>&lt;PIN_code&gt;</p> | <p><b>Enable SECURITY</b></p> <p><u>security_mode parameter (1 octet):</u><br/>1-Security Mode 1<br/>2-N/A<br/>3-Security Mode 3 (default)</p> <p><u>link_key_information parameter (1 octet):</u><br/>1-Inform about link key<br/>2-Don't inform about link key (default)</p> <p><u>PIN_type parameter (1 octet):</u><br/>1-Variable PIN<br/>2-Fixed PIN</p> <p><u>length_PIN_code parameter (2 octets / DEC base):</u><br/>Length of PIN code. The maximum PIN length value is 16 ( corresponding to a 16 octets long PIN code)</p> <p><u>PIN_code parameter (length=length_PIN_code):</u><br/>Normal user PIN, for example "0000" (default), This parameter is taken into account if PIN_TYPE is fixed.</p> <p>Note: If security mode shall be changed from default settings, AT+JSEC shall be the first command that is sent after a reset. Security mode 3 is the default security mode and the default PIN type is variable.</p> | <p>OK</p>                          | <p>Dev A<br/>Dev B</p> |

**Table 6-4**

| AT Command   | Usage  | Resulting response(s) from PAN1321   | DevA / Dev B           |
|--|--|--|------------------------|
| <p>AT+JSNF=<br/>&lt;sniff_Max&gt;,<br/>&lt;sniff_Min&gt;,<br/>&lt;sniff_attempt&gt;,<br/>&lt;sniff_tmo&gt;,<br/>&lt;on/off&gt;</p> | <p><b>Sniff Request</b><br/>Request a link to enter Sniff Mode. All command parameters are given in HEX base with the exception of on/off parameter. 1 ASCII character represents four bits in HEX base e.g. "A" is 1010. MSB given first.</p> <p><u>sniff_Max parameter (4 octets / HEX base):</u><br/>Maximum allowed sniff interval<br/>Value to be written= N<br/>Time = N * 0.625 msec<br/>Range: 1.25 msec to 40.9 s</p> <p><u>sniff_Min parameter (4 octets / HEX base):</u><br/>Minimum allowed sniff interval<br/>Value to be written= N<br/>Time = N * 0.625 msec<br/>Range: 1.25 msec to 40.9 s</p> <p><u>sniff_attempt parameter (4 octets / HEX base):</u><br/>Number of sniff attempts<br/>Value to be written= N<br/>Length = N* 1.25 msec<br/>Time Range: 0.625msec - 40.9 s</p> <p><u>sniff_tmo parameter (4 octets / HEX base):</u><br/>The time out value for sniff attempts<br/>Value to be written= N<br/>Time = N * 0.625 msec<br/>Range: 0 msec to 40.9 s</p> <p><u>on/off parameter (1 octet):</u><br/>One octet to indicate Sniff ON (value=1) or Sniff OFF (value=0)</p> | <p>+RSNFCNF=<br/>&lt;sniff_Interval&gt;,<br/>&lt;mode&gt;</p> <p>sniff_Interval parameter (4 octets / HEX base):<br/>mode parameter (1 octet):<br/>One octet to indicate normal mode (mode=0) or sniff mode (mode=2)</p> | <p>Dev A<br/>Dev B</p> |

**Table 6-4**

| AT Command | Usage  | Resulting response(s) from PAN1321 | DevA / Dev B   |
|------------|--|------------------------------------|----------------|
| ^^^        | <p><b>Stream Connection Cancel</b><br/>End Streaming Mode<br/>Send -T0 - ^ -T1- ^ -T1- ^ -T0- with an interval of T1= 1 second between symbols and T0 &gt; 1second.</p> <p>Note: This string is not terminated with CR LF.</p> | OK                                 | Dev A<br>Dev B |

### 6.3.3 AT responses list (not command triggered)

**Table 6-5**

| AT Response         | Usage   | Command to acknowledge the response  | DevA / Dev B   |
|---------------------|---|--|----------------|
| ROK                 | <b>Start up response</b>  |  | Dev A<br>Dev B |
| +RPCI=<br><bd_addr> | <p><b>Pin Code Indication</b></p> <p><u>bd_addr parameter (12 octets / HEX base):</u><br/>MSB first e.g. 123456789ABC becomes CBA987654321.</p>   | <p>AT+JPCR=<br/>&lt;length_PIN_code&gt;,<br/>&lt;PIN_code&gt;</p> <p>length_PIN_code parameter (2 octets / DEC base):<br/>Length of PIN code<br/>PIN_code parameter (length=length_PIN_code)</p> | Dev A<br>Dev B |
| +RCOI=<br><bd_addr> | <p><b>Connect Indication</b></p> <p><u>bd_addr parameter (12 octets / HEX base):</u><br/>See previous response for information on the format.</p> | <p>AT+JACR= &lt;accept&gt;</p> <p>accept parameter (1 octet):<br/>0 - Not accepted<br/>1 - Accepted</p>  | Dev B          |

**Table 6-5**

| AT Response                              | Usage   | Command to acknowledge the response                                  | Dev A / Dev B  |
|--|---|--|----------------|
| +RDAI=<length>,<br><data>                | <b>Data Indication</b><br><br><u>length parameter (3 octets / DEC base):</u><br>number of bytes to be sent<br><u>data parameter (length=length from previous parameter):</u><br>Received data               | Not available during stream mode.                                    | Dev A<br>Dev B |
| +RDII                                    | <b>Disconnect Indication</b>  | Received on the side that has not initiated the disconnection.       | Dev A<br>Dev B |
| +RSLE                                    | <b>Secure Link Established</b>  |  | Dev A<br>Dev B |
| +RSNFCNF=<br><sniff_interval>,<br><mode> | <b>Sniff mode confirmation</b><br><u>sniff_interval_parameter (4 octets / HEX base).</u><br><br><u>mode parameter (1 octet):</u><br>One octet to indicate<br>Normal mode (mode=0) or<br>sniff mode (mode=2) | Received on the side that has not issued the sniff command (AT+JSNF) | Dev A<br>Dev B |

### 6.4 Example AT commands

**Table 6-6**

| Example: Service Discovery |                   |                            |       |                   |  |
|----------------------------|-------------------|----------------------------|-------|-------------------|--|
| Dev A                      |                   |                            | Dev B |                   |  |
| #                          | Direction         | Command / Event            | #     | Direction         | Command / Event                        |
| 1                          | Host ←<br>PAN1321 | ROK                        |       |                   |  |
|                            |                   |                            | 2     | Host ←<br>PAN1321 | ROK                                    |
|                            |                   |                            | 3     | Host →<br>PAN1321 | AT+JSEC=1,1,1,04,1111                  |
|                            |                   |                            | 4     | Host ←<br>PAN1321 | OK                                     |
|                            |                   |                            | 5     | Host →<br>PAN1321 | AT+JDIS=3                              |
|                            |                   |                            | 6     | Host ←<br>PAN1321 | OK                                     |
|                            |                   |                            | 7     | Host →<br>PAN1321 | AT+JRLS=1101,11, Serial Port,01,000000 |
|                            |                   |                            | 8     | Host ←<br>PAN1321 | OK                                     |
| 9                          | Host →<br>PAN1321 | AT+JSEC=1,,1,1,04,1111     |       |                   |  |
| 10                         | Host ←<br>PAN1321 | OK                         |       |                   |  |
| 11                         | Host →<br>PAN1321 | AT+JSDS=0003199E8B25,<br>1 |       |                   |  |
| 12                         | Host ←<br>PAN1321 | OK                         |       |                   |  |
| 13                         | Host ←<br>PAN1321 | +RSDSRES=Serial Port, 01   |       |                   |  |
| 14                         | Host ←<br>PAN1321 | +RSDSCNF=0                 |       |                   |  |

**Table 6-7**

| Dev A<br>Security mode 3 (default) |                   |                             | Dev B<br>Security mode 3 (default) |                   |   |
|------------------------------------|-------------------|-----------------------------|------------------------------------|-------------------|---|
| #                                  | Direction         | Command / Event             | #                                  | Direction         | Command / Event                           |
| 1                                  | Host ←<br>PAN1321 | ROK                         |                                    |                   |   |
|                                    |                   |                             | 2                                  | Host ←<br>PAN1321 | ROK                                       |
|                                    |                   |                             | 3                                  | Host →<br>PAN1321 | AT+JDIS=3                                 |
|                                    |                   |                             | 4                                  | Host ←<br>PAN1321 | OK  |
|                                    |                   |                             | 5                                  | Host →<br>PAN1321 | AT+JRLS=1101,11,Serial<br>port,01, 000000 |
|                                    |                   |                             | 6                                  | Host ←<br>PAN1321 | OK  |
|                                    |                   |                             | 7                                  | Host →<br>PAN1321 | AT+JAAC=1                                 |
|                                    |                   |                             | 8                                  | Host ←<br>PAN1321 | OK  |
| 9                                  | Host →<br>PAN1321 | AT+JCCR=<br>0003199E8B25,01 |                                    |                   |   |
| 10                                 | Host ←<br>PAN1321 | OK                          |                                    |                   |   |
| 11                                 | Host ←<br>PAN1321 | +RPCI=0003199E8B25          |                                    |                   |   |
| 12                                 | Host →<br>PAN1321 | AT+JPCR=04,0000             |                                    |                   |   |
| 13                                 | Host ←<br>PAN1321 | OK                          |                                    |                   |   |
|                                    |                   |                             | 14                                 | Host ←<br>PAN1321 | +RPCI=0003199E8B35                        |
|                                    |                   |                             | 15                                 | Host →<br>PAN1321 | AT+JPCR=04,0000                           |
|                                    |                   |                             | 16                                 | Host ←<br>PAN1321 | OK  |

**Table 6-7**

**Example: Connect (Security mode 3, Default)**

|    |                    |                |    |                    |                    |
|----|--------------------|----------------|----|--------------------|--------------------|
|    |                    |                | 17 | Host <—<br>PAN1321 | +RSLE              |
|    |                    |                | 18 | Host <—<br>PAN1321 | +RCOI=0003199E8B35 |
|    |                    |                | 19 | Host <—<br>PAN1321 | +RCCRCNF=256,0     |
| 20 | Host <—<br>PAN1321 | +RSLE          |    |                    |                    |
| 21 | Host <—<br>PAN1321 | +RCCRCNF=256,0 |    |                    |                    |

**Table 6-8**

| Dev A<br>Security mode 1 |                   |                         | Dev B<br>Security mode 1 |                   |   |
|--------------------------|-------------------|-------------------------|--------------------------|-------------------|---|
| #                        | Direction         | Command / Event         | #                        | Direction         | Command / Event                           |
| 1                        | Host ←<br>PAN1321 | ROK                     |                          |                   |   |
|                          |                   |                         | 2                        | Host ←<br>PAN1321 | ROK                                       |
|                          |                   |                         | 3                        | Host →<br>PAN1321 | AT+JSEC=1,1,1,04,1111                     |
|                          |                   |                         | 4                        | Host ←<br>PAN1321 | OK  |
|                          |                   |                         | 5                        | Host →<br>PAN1321 | AT+JDIS=3                                 |
|                          |                   |                         | 6                        | Host ←<br>PAN1321 | OK  |
|                          |                   |                         | 7                        | Host →<br>PAN1321 | AT+JRLS=1101, 11, Serial Port, 01, 000000 |
|                          |                   |                         | 8                        | Host ←<br>PAN1321 | OK  |
|                          |                   |                         | 9                        | Host →<br>PAN1321 | AT+JAAC=1                                 |
|                          |                   |                         | 10                       | Host ←<br>PAN1321 | OK  |
| 11                       | Host →<br>PAN1321 | AT+JSEC=1,1,1,04,1111   |                          |                   |   |
| 12                       | Host ←<br>PAN1321 | OK                      |                          |                   |   |
| 13                       | Host →<br>PAN1321 | AT+JCCR=0003199E8B25,01 |                          |                   |   |
| 14                       | Host ←<br>PAN1321 | OK                      |                          |                   |   |
| 15                       | Host →<br>PAN1321 | +RCCRCNF=256,0          |                          |                   |   |
|                          |                   |                         | 16                       | Host ←<br>PAN1321 | +RCOI=0003199E8B35<br>+RCCRCNF=256,0      |

## 7 Electrical Characteristics

### 7.1 Absolute Maximum Ratings

Table 7-1 Absolute Maximum Ratings

| Parameter              | Limit Values |         | Unit | Notes                                  |
|------------------------|--------------|---------|------|--|
|                        | Min          | Max     |      |  |
| Storage temperature    | -40          | 125     | °C   | -                                      |
| VSUPPLY supply voltage | -0.3         | 6.0     | V    | -                                      |
| VDDUART supply voltage | -0.9         | 4.0     | V    | -                                      |
| VDD1 supply voltage    | -0.9         | 4.0     | V    | -                                      |
| VREG                   | -0.3         | 4.0     | V    | VSUPPLY > 4 V                          |
| VREG                   | -0.3         | VSUPPLY | V    | VSUPPLY < 4 V                          |
| Input voltage range    | -0.9         | 4.0     | V    | -                                      |
| Output voltage range   | -0.9         | 4.0     | V    | -                                      |
| ESD                    |              | 1.0     | kV   | According to MIL-STD883D method 3015.7 |

**Note:** Stresses above those listed here are likely to cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. Maximum ratings are not operating conditions.

### 7.2 Operating Conditions

Table 7-2 Operating Conditions

| Parameter             | Limit Values |                   | Unit | Notes               |
|-----------------------|--------------|-------------------|------|---------------------|
|                       | Min          | Max               |      |                     |
| Operating temperature | -40          | +70               | °C   | Optional +85°C      |
| VSUPPLY               | 2.9          | 4.1 <sup>1)</sup> | V    | Main supply voltage |
| VDDUART               | 1.35         | 3.63              | V    |                     |
| VDD1                  | 1.35         | 3.63              | V    |                     |

<sup>1)</sup> At ambient temperatures above 65°C the maximum allowed power dissipation in the module is limited to 200 mW

### 7.3 DC Characteristics

#### 7.3.1 Pad Driver and Input Stages

**Table 7-3 Internal1 (1.5 V) supplied Pins (see Chapter 1.5)**

| Parameter                     | Condition                         | Limit Values |      |      | Unit          |
|-------------------------------|-----------------------------------|--------------|------|------|---------------|
|                               |                                   | Min          | Typ  | Max  |               |
| Input low voltage             | -                                 | -0.3         |      | 0.27 | V             |
| Input high voltage            | -                                 | 1.15         |      | 3.6  | V             |
| Output low voltage            | $I_{OL}=1\text{mA}$               |              |      | 0.25 | V             |
| Output high voltage           | $I_{OH}=-1\text{mA}$ ,            | 1.1          |      |      | V             |
| Continuous Load <sup>1)</sup> |                                   |              |      | 1    | mA            |
| Pin Capacitance               |                                   |              |      | 10   | pF            |
| Magnitude Pin Leakage         | input and output drivers disabled |              | 0.01 | 1    | $\mu\text{A}$ |

<sup>1)</sup> The totaled continuous load for all Internal1 supplied pins shall not exceed 2mA at the same time

**Table 7-4 Internal2 (2.5 V) supplied Pins (see Chapter 1.5)**

| Parameter                     | Condition                         | Limit Values |      |      | Unit          |
|-------------------------------|-----------------------------------|--------------|------|------|---------------|
|                               |                                   | Min          | Typ  | Max  |               |
| Input low voltage             | -                                 | -0.3         |      | 0.45 | V             |
| Input high voltage            | -P0.10                            | 1.93         |      | 2.8  | V             |
|                               | -Other pins                       | 1.93         |      | 3.6  | V             |
| Output low voltage            | $I_{OL}=5\text{mA}$               |              |      | 0.25 | V             |
| Output low voltage            | $I_{OL}=2\text{mA}$               |              |      | 0.15 | V             |
| Output high voltage           | $I_{OH}=-5\text{mA}$ ,            | 2.0          |      |      | V             |
| Output high voltage           | $I_{OH}=-2\text{mA}$ ,            | 2.1          |      |      | V             |
| Continuous Load <sup>1)</sup> |                                   |              |      | 5    | mA            |
| Pin Capacitance               |                                   |              |      | 10   | pF            |
| Magnitude Pin Leakage         | input and output drivers disabled |              | 0.01 | 1    | $\mu\text{A}$ |

<sup>1)</sup> The totaled continuous load for all Internal2 supplied pins shall not exceed 35mA at the same time

### Electrical Characteristics

**Table 7-5 VDDUART supplied Pins (see Chapter 1.5)**

| Parameter                     | Condition                              | Limit Values |      |             | Unit |
|-------------------------------|--|--------------|------|-------------|------|
|                               |  | Min          | Typ  | Max         |      |
| Input low voltage             |  | -0.3         |      | 0.2*VDDUART | V    |
| Input high voltage            | P0.5/UARTRXD                           | 0.7*VDDUART  |      | VDDUART     | V    |
|                               | Other pins                             | 0.7*VDDUART  |      | 3.63        | V    |
| Output low voltage            | I <sub>OL</sub> =5mA<br>VDDUART=2.5V   |              |      | 0.25        | V    |
| Output low voltage            | I <sub>OL</sub> =2mA<br>VDDUART=2.5V   |              |      | 0.15        | V    |
| Output high voltage           | I <sub>OH</sub> =-5mA,<br>VDDUART=2.5V | VDDUART-0.25 |      |             | V    |
| Output high voltage           | I <sub>OH</sub> =-2mA,<br>VDDUART=2.5V | VDDUART-0.15 |      |             | V    |
| Continuous Load <sup>1)</sup> |  |              |      | 5           | mA   |
| Pin Capacitance               |  |              |      | 10          | pF   |
| Magnitude Pin Leakage         | input and output drivers disabled      |              | 0.01 | 1           | μA   |

<sup>1)</sup> The totaled continuous load for all VDDUART supplied pins shall not exceed 35mA at the same time

**Table 7-6 VDD1 supplied Pins (see Chapter 1.5)**

| Parameter                     | Condition                           | Limit Values |     |          | Unit |
|-------------------------------|-------------------------------------|--------------|-----|----------|------|
|                               |                                     | Min          | Typ | Max      |      |
| Input low voltage             |                                     | -0.3         |     | 0.2*VDD1 | V    |
| Input high voltage            |                                     | 0.7*VDD1     |     | 3.63     | V    |
| Output low voltage            | I <sub>OL</sub> =5mA<br>VDD1=2.5V   |              |     | 0.25     | V    |
| Output low voltage            | I <sub>OL</sub> =2mA<br>VDD1=2.5V   |              |     | 0.15     | V    |
| Output high voltage           | I <sub>OH</sub> =-5mA,<br>VDD1=2.5V | VDD1-0.25    |     |          | V    |
| Output high voltage           | I <sub>OH</sub> =-2mA,<br>VDD1=2.5V | VDD1-0.15    |     |          | V    |
| Continuous Load <sup>1)</sup> |                                     |              |     | 5        | mA   |

### Electrical Characteristics

| Parameter             | Condition                         | Limit Values |      |     | Unit |
|-----------------------|-----------------------------------|--------------|------|-----|------|
|                       |                                   | Min          | Typ  | Max |      |
| Pin Capacitance       |                                   |              |      | 10  | pF   |
| Magnitude Pin Leakage | input and output drivers disabled |              | 0.01 | 1   | μA   |

<sup>1)</sup> The total continuous load for all VDD1 supplied pins shall not exceed 35mA at the same time

**Table 7-7 ONOFF PIN (see Chapter 1.5)**

| Parameter          | Condition              | Limit Values      |                    |                       | Unit  |
|--------------------|------------------------|-------------------|--------------------|-----------------------|-------|
|                    |                        | Min               | Typ                | Max                   |       |
| Input low voltage  |                        |                   |                    | 0.15 <sup>1)</sup>    | V     |
| Input high voltage |                        | 1.7 <sup>1)</sup> |                    | VSUPPLY <sup>1)</sup> | V     |
| Input current      | ONOFF=0V               | -2 <sup>1)</sup>  | 0.01 <sup>1)</sup> | 2 <sup>1)</sup>       | μA    |
| Slew-Rate          | When turning ON or OFF | 40 <sup>1)</sup>  |                    |                       | mV/μs |

<sup>1)</sup> Value will be updated after Verification/characterization

### 7.3.2 Pull-ups and Pull-downs

**Table 7-8 Pull-up and pull-down currents**

| Pin   | Pull Up Current |     |      | Pull Down Current |     |     | Unit | Conditions  |
|---|-----------------|-----|------|-------------------|-----|-----|------|---|
|   | Min             | Typ | Max  | Min               | Typ | Max |      |   |
| P0.12/SDA0,<br>P0.13/SCL0   | 260             | 740 | 1300 | N/A               | N/A | N/A | μA   | Pull-up current measured with pin voltage = 0V  |
| TRST#, JTAG#,<br>P0.0,<br>P0.1,<br>P0.2,<br>P0.3  | 22              | 130 | 350  | 23                | 150 | 380 | μA   |   |
| P0.4/UARTTXD,<br>P0.5/UARTRXD,<br>P0.6/UARTRTS,<br>P0.7/UARTCTS,<br>P0.10,<br>P0.8,<br>P0.9,<br>P0.11<br>P0.14,<br>P0.15/SLEEPX | 4.2             | 24  | 68   | 3.0               | 20  | 55  | μA   | Min measured at 125°C with supply = 1.35V<br><br>Typ measured at 27°C with supply = 2.5V<br><br>Max measured at -40°C with supply = 3.63V |
| P1.0/TMS,<br>P1.1/TCK,<br>P1.2/TDI,<br>P1.3/TDO,<br>P1.4/RTCK,<br>P1.5/CLK32,<br>P1.6,<br>P1.7,<br>P1.8                         | 1.1             | 6.0 | 17   | 0.75              | 5.0 | 14  | μA   |   |

### 7.3.3 Protection Circuits

All pins have an inverse protection diode against VSS.  
P0.10 has an inverse diode against Internal2.  
P0.5/UARTRXD has an inverse diode against VDDUART.  
All other pins have no diode against their supply.

### 7.4 System Power Consumption

**Table 7-9 Current Consumption In Different Operating Modes**

This table shows the Vsupply current consumption. All I/O current is neglected since they depend mainly on the external load.

T=25°C, Output Power=0dBm,

| Parameters                  | Min | Typ  | Max | Unit | Comment                                      |
|-----------------------------|-----|------|-----|------|--|
| Ultra Low Power Mode        |     | 30   |     | μA   | VDDPM from internal regulator                |
| Page & Inquiry Scan (1.28s) |     | 0.89 |     | mA   |  |
| Sniff (1.28s)               |     | 0.20 |     | mA   |  |
| ACL (Transmit DH1)          |     | 38   |     | mA   | Basic Rate, 179.2 kb/s <sup>1)</sup>         |
| ACL (Receive DH1)           |     | 35   |     | mA   | Basic Rate, 179.2 kb/s <sup>1)</sup>         |
| ACL (Transmit 2-DH1)        |     | 40   |     | mA   | Enhanced Data Rate, 345.6 kb/s <sup>1)</sup> |
| ACL (Receive 2-DH1)         |     | 37   |     | mA   | Enhanced Data Rate, 345.6 kb/s <sup>1)</sup> |
| ACL (Transmit 3-DH1)        |     | 40   |     | mA   | Enhanced Data Rate, 531.2 kb/s <sup>1)</sup> |
| ACL (Receive 3-DH1)         |     | 37   |     | mA   | Enhanced Data Rate, 531.2 kb/s <sup>1)</sup> |
| SCO (HV3)                   |     | 19   |     | mA   |  |

<sup>1)</sup> Figure indicates maximum possible data rate with this packet type

**Table 7-10 Max. Load at the Different Supply Voltages**

I/O currents are not included since they depend mainly on external loads.

| Parameters | Min | Typ | Max | Unit | Comment      |
|------------|-----|-----|-----|------|--------------|
| Vsupply    |     |     | 100 | mA   | peak current |

### 7.5 AC Characteristics

#### 7.5.1 Characteristics of 32.768 kHz Clock Signal

The 32.768 kHz clock signal applied to CLK32 must be a rectangular waveform with a duty cycle of between 10-90%. The frequency accuracy must be better than 250 ppm. The rise and fall time of the signal must be less than 10 μs.

### 7.6 RF Part

#### 7.6.1 Characteristics RF Part

The characteristics involve the spread of values to be within the specific temperature range. Typical characteristics are the median of the production.

All values refers to Infineon reference design. All values will be updated after verification/ Characterisation.

##### 7.6.1.1 Bluetooth Related Specifications

**Table 7-11 BDR - Transmitter Part**

| Parameters   | Min  | Typ    | Max    | Unit | Conditions   |
|--|------|--------|--------|------|--|
| Output power (high gain)                           | 0.5  | 2.5    | 4.5    | dBm  | Default settings                                     |
| Output power (highest gain)                        |      | 4.5    |        | dBm  | Maximum settings                                     |
| Power control step size                            | 4    | 6      | 8      | dB   |  |
| Frequency range fL                                 | 2400 | 2401.3 |        | MHz  |  |
| Frequency range fH                                 |      | 2480.7 | 2483.5 | MHz  |  |
| 20dB bandwidth                                     |      | 0.930  | 1      | MHz  |  |
| 2nd adjacent channel power                         |      | -40    | -20    | dBm  |  |
| 3rd adjacent channel power                         |      | -60    | -40    | dBm  |  |
| >3rd adjacent channel power                        |      | -64    | -40    | dBm  | max. 2 of 3 exceptions @ 52 MHz offset might be used |
| Average modulation deviation for 00001111 sequence | 140  | 156    | 175    | kHz  |  |
| Minimum modulation deviation for 01010101 sequence | 115  | 145    |        | kHz  |  |
| Ratio Deviation 01010101 / Deviation 00001111      | 0.8  | 1      |        |      |  |
| Initial carrier frequency tolerance  foffset       |      |        | 75     | kHz  |  |
| Carrier frequency drift (one slot)  fdrift         |      | 10     | 25     | kHz  |  |
| Carrier frequency drift (three slots)  fdrift      |      | 10     | 40     | kHz  |  |
| Carrier frequency drift (five slots)  fdrift       |      | 10     | 40     | kHz  |  |

## Electrical Characteristics

**Table 7-11 BDR - Transmitter Part**

| Parameters   | Min | Typ | Max | Unit         | Conditions |
|--|-----|-----|-----|--------------|------------|
| Carrier frequency drift rate (one slot)  fdriftrate    |     | 5   | 20  | kHz/<br>50μs |            |
| Carrier frequency drift rate (three slots)  fdriftrate |     | 5   | 20  | kHz/<br>50μs |            |
| Carrier frequency drift rate (five slots)  fdriftrate  |     | 5   | 20  | kHz/<br>50μs |            |

**Table 7-12 BDR - Receiver Part**

| Parameters  | Min | Typ | Max | Unit | Conditions   |
|---|-----|-----|-----|------|--|
| Sensitivity   |     | -86 | -81 | dBm  | ideal wanted signal  |
| C/I-performance:<br>-4th adjacent channel                     |     | -51 | -40 | dB   |  |
| C/I-performance:<br>-3rd adjacent channel (1st adj. of image) |     | -46 | -20 | dB   |  |
| C/I-performance:<br>-2nd adjacent channel (image)             |     | -35 | -9  | dB   |  |
| C/I-performance:<br>-1st adjacent channel                     |     | -4  | 0   | dB   |  |
| C/I-performance: co. channel                                  |     | 9   | 11  | dB   |  |
| C/I-performance:<br>+1st adjacent channel                     |     | -4  | 0   | dB   |  |
| C/I-performance:<br>+2nd adjacent channel                     |     | -40 | -30 | dB   |  |
| C/I-performance:<br>+3rd adjacent channel                     |     | -50 | -40 | dB   |  |
| Blocking performance<br>30MHz-2GHz                            | 10  |     |     | dBm  | some spurious responses, but according to BT-specification |
| Blocking performance<br>2GHz-2.4GHz                           | -27 |     |     | dBm  |  |
| Blocking performance<br>2.5GHz-3GHz                           | -27 |     |     | dBm  |  |

## Electrical Characteristics

**Table 7-12 BDR - Receiver Part**

| Parameters                            | Min | Typ | Max | Unit | Conditions   |
|---------------------------------------|-----|-----|-----|------|--|
| Blocking performance<br>3GHz-12.75GHz | 10  |     |     | dBm  | some spurious responses, but according to BT-specification |
| Intermodulation performance           | -39 | -34 |     | dBm  | valid for all intermodulation tests                        |
| Maximum input level                   | -20 |     |     | dBm  |  |

**Table 7-13 EDR - Transmitter Part**

| Parameters  | Min | Typ  | Max | Unit | Conditions                            |
|---|-----|------|-----|------|---------------------------------------|
| Output power (high gain)                            | -2  | 0    | 2   | dBm  |                                       |
| Relative transmit power: PxPSK<br>- PGFSK           | -4  | -0.6 | 1   | dB   |                                       |
| Carrier frequency stability $ \omega_i $            |     |      | 75  | kHz  |                                       |
| Carrier frequency stability $ \omega_i + \omega_0 $ |     |      | 75  | kHz  |                                       |
| Carrier frequency stability $ \omega_0 $            |     | 2    | 10  | kHz  |                                       |
| DPSK - RMS DEVM                                     |     | 10   | 20  | %    |                                       |
| 8DPSK - RMS DEVM                                    |     | 10   | 13  | %    |                                       |
| DPSK - Peak DEVM                                    |     | 20   | 35  | %    |                                       |
| 8DPSK - Peak DEVM                                   |     | 20   | 25  | %    |                                       |
| DPSK - 99% DEVM                                     |     |      | 30  | %    |                                       |
| 8DPSK - 99% DEVM                                    |     |      | 20  | %    |                                       |
| Differential phase encoding                         | 99  | 100  |     | %    |                                       |
| 1st adjacent channel power                          |     | -40  | -26 | dBc  |                                       |
| 2nd adjacent channel power                          |     |      | -20 | dBm  | Carrier power measured at basic rate. |
| $\geq 3$ rd adjacent channel power                  |     |      | -40 | dBm  | Carrier power measured at basic rate. |

**Table 7-14 EDR - Receiver Part**

| Parameters   | Min | Typ | Max | Unit | Conditions          |
|--|-----|-----|-----|------|---------------------|
| DQPSK-Sensitivity  |     | -88 | -83 | dBm  | ideal wanted signal |
| 8DPSK-Sensitivity  |     | -83 | -78 | dBm  | ideal wanted signal |
| DQPSK - BER Floor Sensitivity  |     | -84 | -60 | dBm  |                     |
| 8DPSK - BER Floor Sensitivity  |     | -79 | -60 | dBm  |                     |
| DQPSK - C/I-performance:<br>-4th adjacent channel                        |     | -53 | -40 | dB   |                     |
| DQPSK - C/I-performance:<br>-3rd adjacent channel (1st adj.<br>of image) |     | -47 | -20 | dB   |                     |
| DQPSK - C/I-performance:<br>-2nd adjacent channel (image)                |     | -31 | -7  | dB   |                     |
| DQPSK - C/I-performance:<br>-1st adjacent channel                        |     | -7  | 0   | dB   |                     |
| DQPSK - C/I-performance:<br>co. channel                                  |     | 11  | 13  | dB   |                     |
| DQPSK - C/I-performance:<br>+1st adjacent channel                        |     | -9  | 0   | dB   |                     |
| DQPSK - C/I-performance:<br>+2nd adjacent channel                        |     | -44 | -30 | dB   |                     |
| DQPSK - C/I-performance:<br>+3rd adjacent channel                        |     | -50 | -40 | dB   |                     |
| 8DPSK - C/I-performance:<br>-4th adjacent channel                        |     | -48 | -33 | dB   |                     |
| 8DPSK - C/I-performance:<br>-3rd adjacent channel (1st adj.<br>of image) |     | -44 | -13 | dB   |                     |
| 8DPSK - C/I-performance:<br>-2nd adjacent channel (image)                |     | -25 | 0   | dB   |                     |
| 8DPSK - C/I-performance:<br>-1st adjacent channel                        |     | -5  | 5   | dB   |                     |
| 8DPSK - C/I-performance:<br>co. channel                                  |     | 17  | 21  | dB   |                     |
| 8DPSK - C/I-performance:<br>+1st adjacent channel                        |     | -5  | 5   | dB   |                     |
| 8DPSK - C/I-performance:<br>+2nd adjacent channel                        |     | -36 | -25 | dB   |                     |

### Electrical Characteristics

**Table 7-14 EDR - Receiver Part**

| Parameters  | Min | Typ | Max | Unit | Conditions |
|---|-----|-----|-----|------|------------|
| 8DPSK - C/I-performance:<br>+3rd adjacent channel |     | -46 | -33 | dB   |            |
| Maximum input level                               | -20 |     |     | dBm  |            |

8 Package Information

8.1 Package Marking

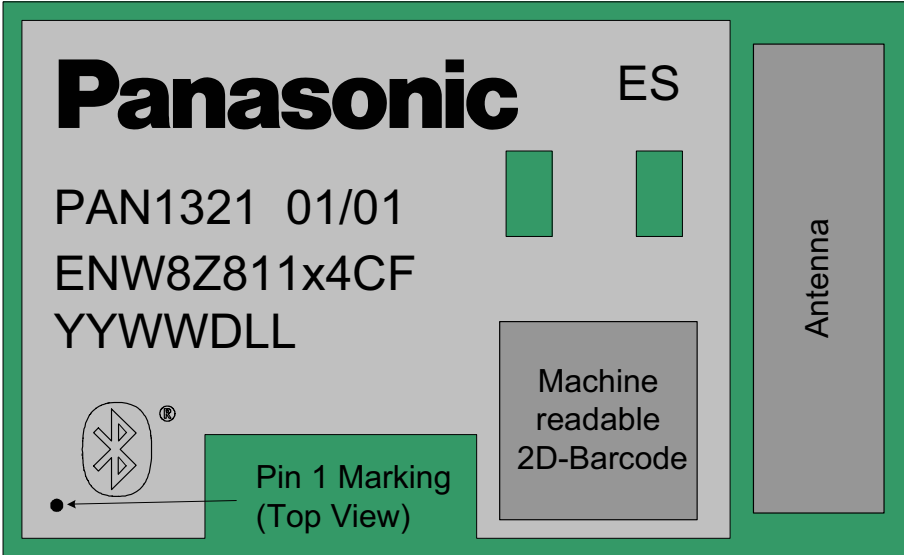


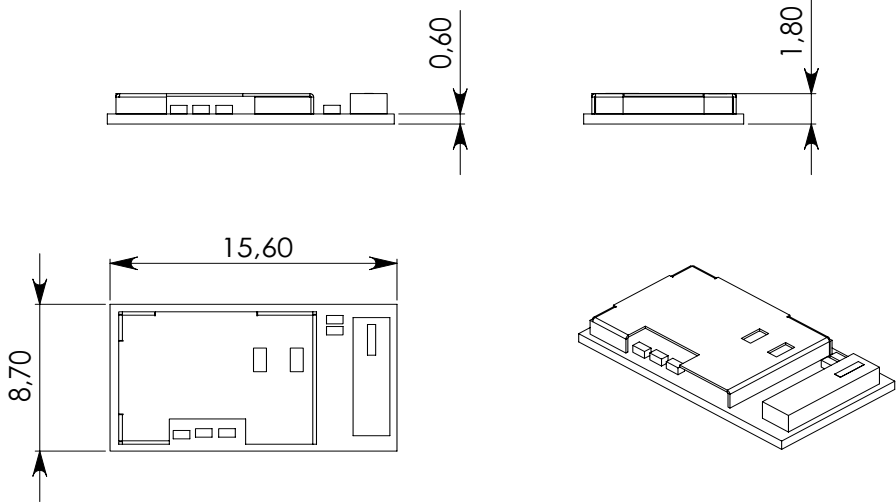
Figure 8-1 PAN1321 Top View

Table 8-1 Marking Explanation

| Marking      | Remark   |
|--------------|--|
| PAN1321      | Product Name   |
| 01/01        | Revision Hardware/Software <sup>1)</sup>                     |
| ENW8Z811x4CF | Ordering Code<br>please refer to <a href="#">Chapter 1.2</a> |
| ES           | Engineering Sample, no mass production product now           |
| YYWWDLL      | Date Code  |

<sup>1)</sup> This is only related to the BD Data values for the EEPROM.

### 8.2 Production Package



All dimensions are in mm.

Tolerances on all outer dimensions, height, width and length, are +/- 0.2 mm.



## 10 Assembly Guideline

The target of this section is to provide guidelines for customers to successfully introduce the PAN1321 module in production. This includes general description, PCB-design, solder printing process, assembly, soldering process, rework and inspection.

### 10.1 General description of the module

PAN1321 is a Land Grid Array (LGA 11,6 mm x 8,7 mm) module made for surface mounting. The pad diameter is 0.6 mm and the pitch 1.2 mm.

All solder joints on the module will reflow during soldering on the mother board. All components and shield will stay in place due to wetting force.

Surface treatment on the module pads is Nickel (5-8  $\mu\text{m}$ )/Gold (0.04-0.10  $\mu\text{m}$ ).

Figure 10-1 shows the pad layout on the module, seen from component side.

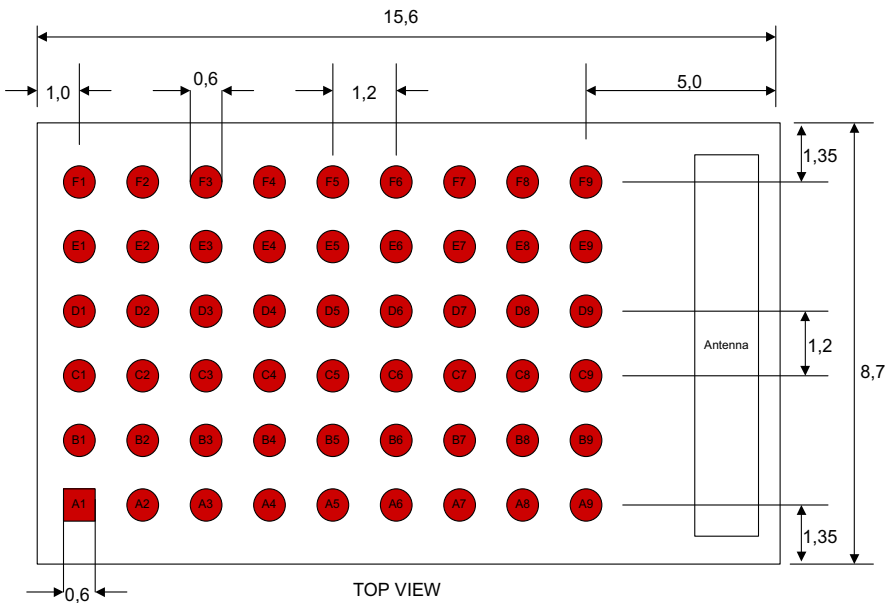


Figure 10-1 Pad layout on the module (top view).

### 10.2 Printed Circuit Board design

The land pattern on the PCB shall be according to the land pattern on the module, which means that the diameter of the LGA pads on the PCB shall be 0.6 mm. It is recommended that each pad on the PCB shall be surrounded by a solder mask clearance of about 75  $\mu\text{m}$  to avoid overlapping solder mask and pad.

### 10.3 Solder paste printing

The solder paste deposited on the PCB by stencil printing has to be of eutectic or near eutectic tin leadfree / lead composition. A no-clean solder paste is preferred, since cleaning of the solder joints is difficult because of the small gap.

Preferred thickness of the solder paste stencil is 100 - 127  $\mu\text{m}$  (4 - 5 mils). The apertures on the solder paste stencil shall be of the same size as the pads, 0.6 mm.

### 10.4 Assembly

#### 10.4.1 Component placement

In order to assure a high yield, good placement on the PCB is necessary. As a rule of thumb the tolerable misplacement is 150  $\mu\text{m}$ . This means that the PAN1321 module can be assembled with a variety of placement systems.

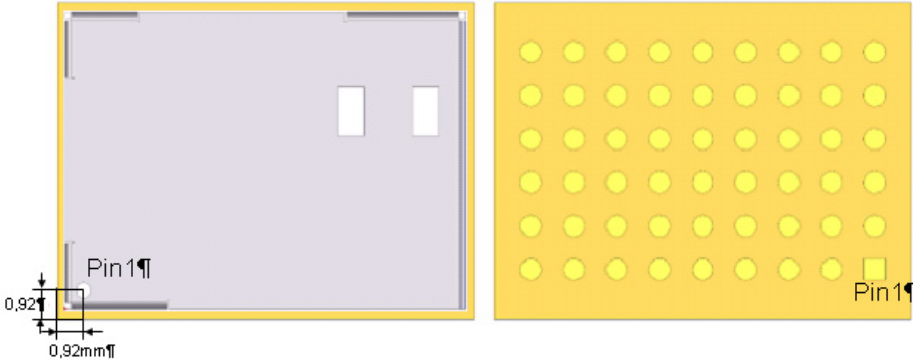
It is recommended to use a vision system capable of package pad recognition and alignment that evaluates the pad locations on the package (in contrast to outline centring). This eliminates the pad to package edge tolerance.

The recommendation is to pick and place the module with a nozzle in the centre of the shield. The nozzle diameter shall not be bigger than 4 mm.

### 10.4.2 Pin mark

Pin 1 (A0) is marked on bottom footprint and on the top of the shield on the module according to **Figure 10-2**. Diameter of pin 1 mark on the shield is 0.40 mm.

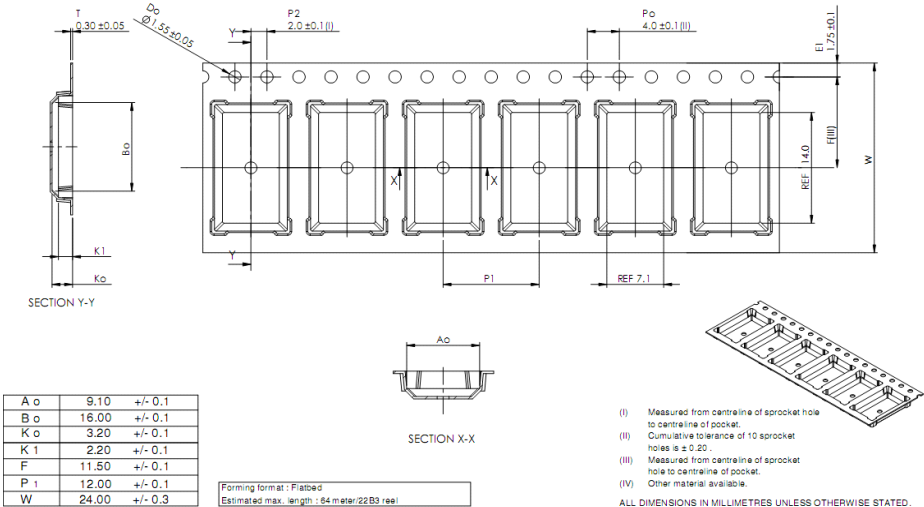
**Figure 10-2 Topview and bottom view**



### 10.4.3 Package

PAN1321 is packed in tape on reel according to **Figure 10-3**.

**Figure 10-3 Tape and reel**



## 10.5 Solder Profile

Generally all standard reflow soldering processes (vapour phase, convection, infra red) and typical temperature profiles used for surface mount devices are suitable for the PAN1321 module. Wave soldering is not possible. [Figure 10-4](#) and [Figure 10-5](#) shows example of a suitable solder reflow profile. One for leaded and one for leadfree solder.

At the reflow process each solder joint has to be exposed to temperatures above solder liquids for a sufficient time to get the optimum solder joint quality, whereas overheating the board with its components has to be avoided. Using infrared ovens without convection special care may be necessary to assure a sufficiently homogeneous temperature profile for all solder joints on the PCB (especially on large, complex boards with different thermal masses of the components). The most recommended types are therefore forced convection or vapour phase reflow. Nitrogen atmosphere can generally improve solder joint quality, but is normally not necessary.

The reflow profiles and other reflow parameters are dependent on the used solder paste. The paste manufacturer provides a reflow profile recommendation for this product.

Additionally it is important not to overheat the PAN1321 module by a too large reflow peak temperature. PAN1321 contain several plastic packages and is there by sensitive of the moisture content level at the time of board assembly.

Overheating in combination with excessive moisture content could result in package delaminations or cracks (popcorn effect). The heating rate should not exceed 3°C/s and max sloping rate should not exceed 4°C/s.

PAN1321 shall be handled according to MSL3, which means a floor life of 168 h in 30°C/60% r.h.

Figure 10-4 Eutectic Lead-Solder Profile

Recommended temp. profile for reflow soldering

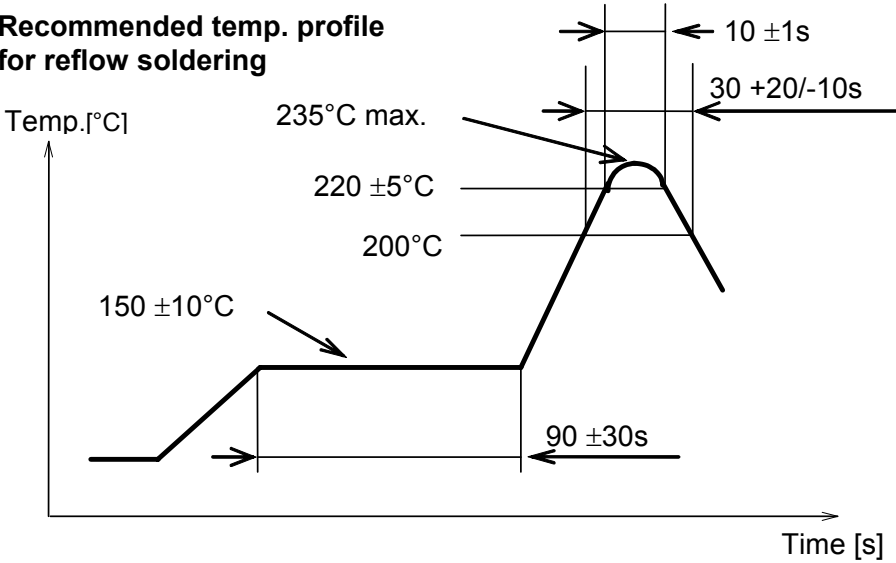
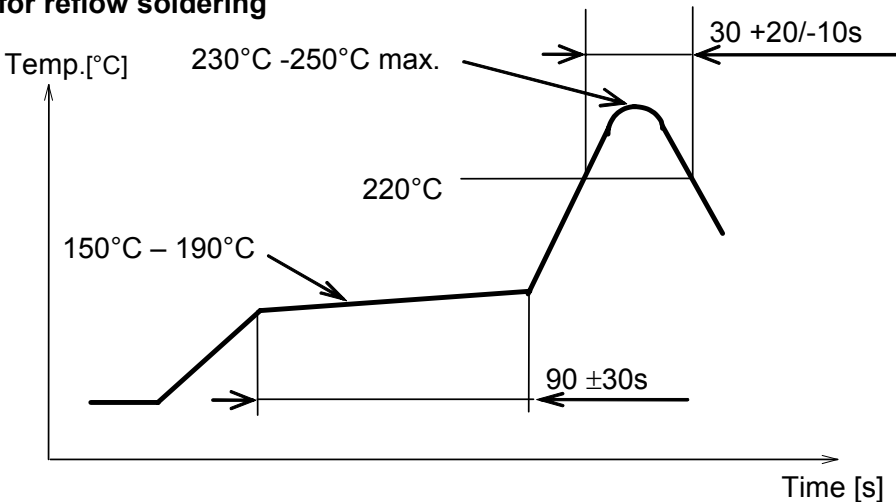


Figure 10-5 Eutectic Leadfree-Solder Profile

Recommended temp. profile for reflow soldering



#### 10.6 Inspection

Automatic inspection of the solder paste printing before assembly is highly recommended to ensure high yield and good long term reliability.

#### 10.7 Component salvage

If it is intended to send a defect PAN1321 module back to the supplier for failure analysis, please note that during the removal of this component no further defects must be introduced to the device, because this may hinder the failure analysis at the supplier. This includes ESD precautions, not to apply high mechanical force for component removal, and to prevent excess moisture content in the package during salvage (risk of pop corning failures). Therefore if the maximum storage time out of the dry pack (see label on packing material) is exceeded after board assembly, the PCB has to be dried 24h at 125°C before soldering off the defect component, because otherwise too much moisture may have been accumulated.

## **11 Acronyms & Abbreviations**

**Table 1**

| <b>Acronym or abbreviation</b> | <b>Writing out in full</b>                              |
|--------------------------------|---|
| ACK                            | Acknowledgement   |
| ACL                            | Asynchronous Connection-oriented (logical transport)    |
| AFH                            | Adaptive Frequency Hopping                              |
| AHS                            | Adaptive Hop Sequence                                   |
| ARQ                            | Automatic Repeat reQuest                                |
| b                              | bit/bits (e.g. kb/s)                                    |
| B                              | Byte/Bytes (e.g. kB/s)                                  |
| BALUN                          | BALanced UNbalanced                                     |
| BD_ADDR                        | Bluetooth Device Address                                |
| BER                            | Bit Error Rate  |
| BMU                            | BlueMoon Universal                                      |
| BOM                            | Bill Of Material  |
| BT                             | Bluetooth   |
| BW                             | Bandwidth   |
| CMOS                           | Complementary Metal Oxide Semiconductor                 |
| COD                            | Class Of Device   |
| CODEC                          | COder/DECoder   |
| CPU                            | Central Processing Unit                                 |
| CQDDR                          | Channel Quality Driven Data Rate                        |
| CRC                            | Cyclic Redundancy Check                                 |
| CTS                            | Clear To Send (UART flow control signal)                |
| CVSD                           | Continuous Variable Slope Delta (modulation)            |
| DC                             | Direct Current  |
| DDC                            | Device Data Control                                     |
| DM                             | Data Medium-Rate (packet type)                          |
| DMA                            | Direct Memory Access                                    |
| DH                             | Data High-Rate (packet type)                            |
| DPSK                           | Differential Phase Shift Keying (modulation)            |
| DQPSK                          | Differential Quaternary Phase Shift Keying (modulation) |
| DSP                            | Digital Signal Processor                                |

## Acronyms & Abbreviations

**Table 1**

| <b>Acronym or abbreviation</b> | <b>Writing out in full</b>                                   |
|--------------------------------|--|
| DUT                            | Device Under Test  |
| CDCT                           | Clock Drift Compensation Task                                |
| CQDDR                          | Channel Quality Driven Data Rate                             |
| EDR                            | Enhanced Data Rate   |
| EEPROM                         | Electrically Erasable Programmable Read Only Memory          |
| eSCO                           | Extended Synchronous Connection-Oriented (logical transport) |
| EV                             | Extended Voice (packet type)                                 |
| FEC                            | Forward Error Correction                                     |
| FHS                            | Frequency Hop Synchronization (packet)                       |
| FIFO                           | First In First Out (buffer)                                  |
| FM                             | Frequency Modulation   |
| FW                             | Firmware   |
| GFSK                           | Gaussian Frequency Shift Keying (modulation)                 |
| GPIO                           | General Purpose Input/Output                                 |
| GSM                            | Global System for Mobile communication                       |
| HCI                            | Host Controller Interface                                    |
| HCI+                           | Infineon Specific HCI command set                            |
| HEC                            | Header Error Check   |
| HV                             | High quality Voice (packet type)                             |
| HW                             | Hardware   |
| I2C                            | Inter-IC Control (bus)                                       |
| I2S                            | Inter-IC Sound (bus)   |
| IAC                            | Inquiry Access Code  |
| ID                             | IDentifier   |
| IEEE                           | Institute of Electrical and Electronics Engineers            |
| IF                             | Intermediate Frequency                                       |
| ISM                            | Industrial Scientific & Medical (frequency band)             |
| JTAG                           | Joint Test Action Group                                      |
| LAN                            | Local Area Network   |
| LAP                            | Lower Address Part   |
| LM                             | Link Manager   |
| LMP                            | Link Manager Protocol  |

## Acronyms & Abbreviations

**Table 1**

| <b>Acronym or abbreviation</b> | <b>Writing out in full</b>                 |
|--------------------------------|--|
| LNA                            | Low Noise Amplifier                        |
| LO                             | Local Oscillator                           |
| LPM                            | Low Power Mode(s)                          |
| LPO                            | Low Power Oscillator                       |
| LSB                            | Least Significant Bit/Byte                 |
| LT_ADDR                        | Logical Transport Address                  |
| MSB                            | Most Significant Bit/Byte                  |
| MSRS                           | Master-Slave Role Switch                   |
| NC                             | No Connection                              |
| NOP                            | No Operation                               |
| NVM                            | Non-Volatile Memory                        |
| OCF                            | Opcode Command Field                       |
| OGF                            | Opcode Group Field                         |
| PA                             | Power Amplifier                            |
| PCB                            | Printed Circuit Board                      |
| PCM                            | Pulse Coded Modulation                     |
| PDU                            | Protocol Data Unit                         |
| PER                            | Packet Error Rate                          |
| PIN                            | Personal Identification Number             |
| PLC                            | Packet Loss Concealment                    |
| PLL                            | Phase Locked Loop                          |
| PMU                            | Power Management Unit                      |
| POR                            | Power-On Reset                             |
| PTA                            | Packet Traffic Arbitration                 |
| PTT                            | Packet Type Table                          |
| QoS                            | Quality Of Service                         |
| RAM                            | Random Access Memory                       |
| RF                             | Radio Frequency                            |
| ROM                            | Read Only Memory                           |
| RSSI                           | Received Signal Strength Indication        |
| RTS                            | Request To Send (UART flow control signal) |
| RX                             | Receive                                    |

## Acronyms & Abbreviations

**Table 1**

| <b>Acronym or abbreviation</b> | <b>Writing out in full</b>                          |
|--------------------------------|---|
| RXD                            | Receive Data (UART signal)                          |
| SCO                            | Synchronous Connection-Oriented (logical transport) |
| SIG                            | Special Interest Group (Bluetooth SIG)              |
| SW                             | Software  |
| SYRI                           | Synthesizer Reference Input                         |
| TBD                            | To Be Determined                                    |
| TCK                            | Test Clock (JTAG signal)                            |
| TDI                            | Test Data In (JTAG signal)                          |
| TDO                            | Test Data Out (JTAG signal)                         |
| TL                             | Transport Layer                                     |
| TMS                            | Test Mode Select (JTAG signal)                      |
| TX                             | Transmit  |
| TXD                            | Transmit Data (UART signal)                         |
| UART                           | Universal Asynchronous Receiver & Transmitter       |
| ULPM                           | Ultra Low Power Mode                                |
| VCO                            | Voltage Controlled Oscillator                       |
| WLAN                           | Wireless LAN (Local Area Network)                   |

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